

# 31 W, Filterless, Class-D Digital Input Audio Amplifier

**Data Sheet** 

# SSM3515

# FEATURES

Filterless digital input, mono Class-D amplifier Operates from a single 4.5 V to 17 V supply 31.3 W output power, 17 V supply, and 4  $\Omega$  load at 1% THD + N 107 dB A-weighted signal-to-noise ratio 93.3% efficiency into 8  $\Omega$  load at 12 V I<sup>2</sup>C control with up to 4 pin selectable slots/addresses Supports multiple serial data formats up to TDM16 Digital interface supports sample rates from 8 kHz to 192 kHz Flexible digital and analog gain adjustment **Flexible supply monitoring AGC function** 6.55 mA guiescent current with single 17 V PVDD supply Short-circuit and thermal protection, thermal warning 20-ball, 1.8 mm × 2.2 mm, 0.4 mm pitch WLCSP Pop and click suppression User selectable ultralow EMI emissions mode Power-on reset

## **APPLICATIONS**

Notebooks Portable electronics Home audio

## **GENERAL DESCRIPTION**

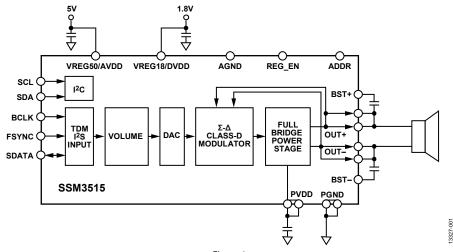
The SSM3515 is a fully integrated, high efficiency, mono Class-D audio amplifier with digital inputs. The application circuit requires a minimum of external components and can operate from a single 4.5 V to 17 V supply. It can deliver 8.4 W of output power into an 8  $\Omega$  load or 15.8 W into an 4  $\Omega$  load from a 12 V power supply, or 31.3 W into an 4  $\Omega$  load from a 17 V power supply, all with 1% THD + N.

The SSM3515 features a high efficiency, low noise modulation scheme that requires no external LC output filters. This scheme provides high efficiency even at low output power. It operates with 92% efficiency at 7 W into an 8  $\Omega$  load or 88% efficiency at 15 W into 4  $\Omega$  from a 12 V supply.

Spread spectrum pulse density modulation provides lower EMI radiated emissions compared with other Class-D architectures, particularly above 100 MHz.

The digital input eliminates the need for an external digital-toanalog converter (DAC). The SSM3515 has a micropower shutdown mode with a typical shutdown current of 39 nA at the 12 V PVDD supply. The device also includes pop and click suppression circuitry that minimizes voltage glitches at the output during turn on and turn off.

The SSM3515 operates with or without an I<sup>2</sup>C control interface. The SSM3515 is specified over the commercial temperature range (-40°C to +85°C). It has built in thermal shutdown and output short-circuit protection. It is available in a halide-free, 20-ball, 1.8 mm × 2.2 mm wafer-level chip scale package (WLCSP).



## FUNCTIONAL BLOCK DIAGRAM

#### Figure 1.

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## **REVISION HISTORY**

| 1/2017—Rev. 0 to Rev. A         |   |
|---------------------------------|---|
| Changes to Figure 2 and Table 5 | 5 |

6/2015—Revision 0: Initial Version

# SPECIFICATIONS

 $PV_{DD} = 12 \text{ V}, \text{VREG50/AVDD} = 5 \text{ V} \text{ (internal)}, \text{VREG18/DVDD} = 1.8 \text{ V} \text{ (external)}, R_L = 8 \Omega + 33 \mu\text{H}, \text{BCLK} = 3.072 \text{ MHz} \text{ and FSYNC} = 48 \text{ kHz}, T_A = -40^{\circ}\text{C} \text{ to} +85^{\circ}\text{C}, \text{ unless otherwise noted}.$  The measurements are with a 20 kHz AES17 low-pass filter. The other load impedances used are  $4 \Omega + 15 \mu\text{H}$  and  $3 \Omega + 10 \mu\text{H}$ . Measurements are with a 20 kHz AES17 low-pass filter, unless otherwise noted.

The sine wave output powers above 20 W in 4  $\Omega$  cannot be continuous and may invoke the thermal limit indicator based on the power dissipation capability of the board.

| Parameter                                | Symbol             | Test Conditions/Comments   | Min  | Тур   | Max  | Unit   |
|--|--------------------|--|------|-------|------|--------|
| DEVICE CHARACTERISTICS                   |                    |  |      |       |      |        |
| Output Power/Channel                     | Pout               | f = 1 kHz  |      |       |      |        |
| $R_L = 8 \Omega$                         |                    | $THD + N = 1\%, PV_{DD} = 17 V$  |      | 16    |      | W      |
|  |                    | $THD + N = 1\%, PV_{DD} = 12 V$  |      | 8.4   |      | W      |
|  |                    | $THD + N = 1\%, PV_{DD} = 7 V$   |      | 2.8   |      | W      |
|  |                    | $THD + N = 1\%, PV_{DD} = 5 V$   |      | 1.4   |      | W      |
|  |                    | $THD + N = 10\%, PV_{DD} = 17 V$   |      | 19.7  |      | W      |
|  |                    | THD + N = 10%, PV <sub>DD</sub> = 12 V   |      | 10.5  |      | W      |
|  |                    | $THD + N = 10\%, PV_{DD} = 7 V$  |      | 3.5   |      | W      |
|  |                    | $THD + N = 10\%, PV_{DD} = 5 V$  |      | 1.8   |      | W      |
| $R_L = 4 \Omega$                         |                    | $THD + N = 1\%, PV_{DD} = 17 V$  |      | 31.3  |      | W      |
|  |                    | $THD + N = 1\%, PV_{DD} = 12 V$  |      | 15.8  |      | W      |
|  |                    | $THD + N = 1\%, PV_{DD} = 7 V$   |      | 5.4   |      | W      |
|  |                    | $THD + N = 1\%, PV_{DD} = 5 V$   |      | 2.8   |      | W      |
|  |                    | $THD + N = 10\%, PV_{DD} = 17 V$   |      | 39.3  |      | W      |
|  |                    | THD + N = 10%, PV <sub>DD</sub> = 12 V   |      | 19.7  |      | W      |
|  |                    | $THD + N = 10\%, PV_{DD} = 7 V$  |      | 6.7   |      | W      |
|  |                    | $THD + N = 10\%, PV_{DD} = 5 V$  |      | 3.4   |      | W      |
| Efficiency                               | η                  | $P_{OUT} = 9 W, R_L = 8 \Omega, PV_{DD} = 12 V$                                      |      | 93.3  |      | %      |
|  |                    | $P_{OUT} = 9 W$ , $R_L = 8 \Omega$ , $PV_{DD} = 12 V$ (low EMI mode)                 |      | 93.2  |      | %      |
|  |                    | $P_{OUT} = 30 \text{ W}, R_L = 4 \Omega, PV_{DD} = 17 \text{ V}$                     |      | 88    |      | %      |
|  |                    | $P_{OUT} = 30 W, R_L = 4 \Omega, PV_{DD} = 17 V$ (low EMI mode)                      |      | 87.8  |      | %      |
| Total Harmonic<br>Distortion + Noise     | THD + N            | $P_{OUT} = 5$ W into $R_L = 8 \Omega$ , $f = 1$ kHz, $PV_{DD} = 16$ V                |      | 0.004 |      | %      |
| Load Resistance                          |                    |  | 3    |       |      | Ω      |
| Load Inductance                          |                    |  | 5    | 10    |      | μH     |
| Output FET On Resistance                 | R <sub>ON</sub>    |  |      | 110   |      | mΩ     |
| Overcurrent Protection<br>Trip Point     | l <sub>oc</sub>    |  | 5.8  |       |      | A peak |
| Average Switching<br>Frequency           | f <sub>sw</sub>    |  |      | 300   |      | kHz    |
| Differential Output DC<br>Offset Voltage | Voos               | Gain = 12.6 V  |      | ±1    | ±5.0 | mV     |
| POWER SUPPLIES                           |                    |  |      |       |      |        |
| Supply Voltage Range                     | PV <sub>DD</sub>   | Guaranteed from PSRR test  | 4.5  |       | 17   | v      |
|  | VREG50/AVDD        | Internal   | 4.5  | 5.0   | 5.5  | V      |
|  | VREG18/DVDD        | Internal or external   | 1.62 | 1.80  | 1.98 | v      |
| AC Power Supply                          | PSRR <sub>AC</sub> | $V_{\text{RIPPLE}} = 1 \text{ V rms at } 1 \text{ kHz}$                              |      | 87    | 73   | dB     |
| Rejection Ratio                          |                    |  |      | 0.    |      |        |
| GAIN CONTROL                             |                    | Measured with 0 dBFS input at 1 kHz  |      |       |      |        |
| Output Voltage Peak                      |                    | Analog gain setting = $8.4 \text{ V/V}$ with $PV_{DD} = 17 \text{ V}$                |      | 8.4   |      | V peal |
| . 5                                      |                    | Analog gain setting = $12.6 \text{ V/V}$ with $\text{PV}_{\text{DD}} = 17 \text{ V}$ |      | 12.6  |      | V peal |
|  |                    | Analog gain setting = $14.0 \text{ V/V}$ with $PV_{DD} = 17 \text{ V}$               |      | 14    |      | V peak |
|  |                    | Analog gain setting = $15.0 \text{ V/V}$ with $\text{PV}_{\text{DD}} = 17 \text{ V}$ | 1    | 15    |      | V peal |

| Parameter                              | Symbol           | Test Conditions/Comments   | Min   | Тур    | Max   | Unit   |
|--|------------------|--|-------|--------|-------|--------|
| SHUTDOWN CONTROL <sup>1</sup>          |                  |  |       |        |       |        |
| Turn On Time, Volume<br>Ramp Disabled  | t <sub>WU</sub>  | Time from SPWDN = 0 to output switching,<br>DAC_HV = 1 or DAC_MUTE = 1, $t_{WU}$ = 4 FSYNC<br>cycles to 7 FSYNC cycles + 7.68 ms |       |        |       |        |
| $f_s = 12 \text{ kHz}$                 |                  | -,   | 8.01  |        | 8.27  | ms     |
| $f_s = 24 \text{ kHz}$                 |                  |  | 7.84  |        | 7.98  | ms     |
| $f_s = 48 \text{ kHz}$                 |                  |  | 7.76  |        | 7.83  | ms     |
| $f_s = 96 \text{ kHz}$                 |                  |  | 7.72  |        | 7.76  | ms     |
| f <sub>s</sub> = 192 kHz               |                  |  | 7.70  |        | 7.72  | ms     |
| Turn On Time, Volume<br>Ramp Enabled   | t <sub>wur</sub> | Time from SPWDN = 0 to full volume output switching, DAC_HV = 0 and DAC_MUTE = 0, VOL = $0x40$                                   |       |        |       |        |
| $f_s = 12 \text{ kHz}$                 |                  | $t_{WUR} = t_{WU} + 15.83 \text{ ms}$  | 23.84 |        | 24.10 | ms     |
| $f_s = 24 \text{ kHz}$                 |                  | $t_{WUR} = t_{WU} + 15.83 \text{ ms}$  | 23.67 |        | 23.81 | ms     |
| $f_s = 48 \text{ kHz}$                 |                  | $t_{WUR} = t_{WU} + 15.83 \text{ ms}$  | 23.59 |        | 23.66 | ms     |
| f <sub>s</sub> = 96 kHz                |                  | $t_{WUR} = t_{WU} + 7.92 \text{ ms}$   | 15.64 |        | 15.68 | ms     |
| $f_s = 192 \text{ kHz}$                |                  | $t_{WUR} = t_{WU} + 0.99 \text{ ms}$   | 8.69  |        | 8.71  | ms     |
| Turn Off Time, Volume<br>Ramp Disabled | t <sub>SD</sub>  | Time from SPWDN = 1 to full power-down,<br>DAC_HV = 1 or DAC_MUTE = 1  |       | 100    |       | μs     |
| Turn Off Time, Volume<br>Ramp Enabled  | t <sub>sDR</sub> | Time from SPWDN = 1 to full power-down,<br>DAC_HV = 0 and DAC_MUTE = $0$ , VOL = $0x40$  |       |        |       |        |
| $f_s = 12 \text{ kHz}$                 |                  | $t_{SDR} = t_{SD} + 15.83 \text{ ms}$  |       | 15.932 |       | ms     |
| $f_s = 24 \text{ kHz}$                 |                  | $t_{SDR} = t_{SD} + 15.83 \text{ ms}$  |       | 15.932 |       | ms     |
| $f_s = 48 \text{ kHz}$                 |                  | $t_{SDR} = t_{SD} + 15.83 \text{ ms}$  |       | 15.932 |       | ms     |
| f <sub>s</sub> = 96 kHz                |                  | $t_{SDR} = t_{SD} + 7.92 \text{ ms}$   |       | 8.016  |       | ms     |
| f <sub>s</sub> = 192 kHz               |                  | $t_{SDR} = t_{SD} + 0.99 \text{ ms}$   |       | 1.09   |       | ms     |
| Output Impedance                       | Z <sub>OUT</sub> |  | 100   |        |       | kΩ     |
| NOISE PERFORMANCE <sup>2</sup>         |                  |  |       |        |       |        |
| Output Voltage Noise                   | en               | $f = 20$ Hz to 20 kHz, A-weighted, $PV_{DD} = 12$ V  |       | 37.5   |       | μV rms |
|  |                  | $f = 20$ Hz to 20 kHz, A-weighted, $PV_{DD} = 17$ V  |       | 48     |       | μV rms |
| Signal-to-Noise Ratio                  | SNR              | $P_{OUT}$ = 8.2 W, $R_L$ = 8 $\Omega$ , A-weighted, $PV_{DD}$ = 12 V   |       | 107    |       | dB     |
|  |                  | $P_{\text{OUT}}\!=$ 31 W, $R_{\text{L}}\!=$ 4 $\Omega,$ A-weighted, $PV_{\text{DD}}\!=$ 17 V                                     |       | 107    |       | dB     |
| PVDD ADC PERFORMANCE                   |                  |  |       |        |       |        |
| PVDD Sense Full-Scale<br>Range         |                  | PVDD with full-scale ADC out   | 3.8   |        | 16.2  | V      |
| PVDD Sense Absolute<br>Accuracy        |                  | $PV_{DD} = 15 V$   | -8    |        | +8    | LSB    |
|  |                  | $PV_{DD} = 5 V$  | -6    |        | +6    | LSB    |
| Resolution                             |                  | Unsigned 8-bit output with 3.8 V offset  |       | 8      |       | Bits   |
| DIE TEMPERATURE                        |                  |  |       |        |       |        |
| Overtemperature                        |                  |  |       | 117    |       | °C     |
| Warning                                |                  |  |       |        |       |        |
| Overtemperature<br>Protection          |                  |  |       | 145    |       | °C     |

<sup>1</sup> Guaranteed by design.

 $^2$  Noise performance is based on the bench data for  $T_A=-40^\circ C$  to  $+85^\circ C.$ 

Software master power-down indicates that the clocks are turned off. Auto power-down indicates that there is no dither or zero input signal with clocks on; the device enters soft power-down after 2048 cycles of zero input values. Quiescent indicates triangular dither with zero input signal. All specifications are typical, with a 48 kHz sample rate, unless otherwise noted.

| Edge Rate |                   |                               |      | No Load $4 \Omega + 15 \mu H$ |      |                    |      |       |      | l I                |                      |      |      |                    |      |
|-----------|-------------------|-------------------------------|------|-------------------------------|------|--------------------|------|-------|------|--------------------|----------------------|------|------|--------------------|------|
| Control   |                   | Test Conditions               |      | IPVDD                         |      | I <sub>REG18</sub> |      | IPVDD |      | I <sub>REG18</sub> | 18 I <sub>PVDD</sub> |      |      | I <sub>REG18</sub> |      |
| Mode      | <b>REG_EN Pin</b> | PV <sub>DD</sub>              | 5 V  | 12 V                          | 17 V | 1.8 V              | 5 V  | 12 V  | 17 V | 1.8 V              | 5 V                  | 12 V | 17 V | 1.8 V              | Unit |
| Normal    | Low               | Software master<br>power-down | 0.01 | 0.03                          | 0.03 | 7                  | 0.01 | 0.03  | 0.03 | 7                  | 0.01                 | 0.03 | 0.03 | 7                  | μA   |
|           |                   | Auto power-down               | 0.01 | 0.03                          | 0.03 | 54                 | 0.01 | 0.03  | 0.03 | 54                 | 0.01                 | 0.03 | 0.03 | 54                 | μΑ   |
|           |                   | Quiescent                     | 4.10 | 5.00                          | 5.60 | 0.48               | 4.10 | 5.12  | 5.90 | 0.48               | 4.10                 | 5.10 | 5.80 | 0.48               | mA   |
|           | PVDD              | Software master<br>power-down | 0.01 | 0.03                          | 0.03 | N/A                | 0.01 | 0.03  | 0.03 | N/A                | 0.01                 | 0.03 | 0.03 | N/A                | μA   |
|           |                   | Auto power-down               | 310  | 310                           | 316  | N/A                | 310  | 310   | 316  | N/A                | 310                  | 310  | 316  | N/A                | μΑ   |
|           |                   | Quiescent                     | 4.64 | 5.60                          | 6.26 | N/A                | 4.74 | 5.85  | 6.55 | N/A                | 4.74                 | 5.85 | 6.55 | N/A                | mA   |
| Low EMI   | Low               | Software master<br>power-down | 0.01 | 0.03                          | 0.03 | 7                  | 0.01 | 0.03  | 0.03 | 7                  | 0.01                 | 0.03 | 0.03 | 7                  | μA   |
|           |                   | Auto power-down               | 0.01 | 0.03                          | 0.03 | 54                 | 0.01 | 0.03  | 0.03 | 54                 | 0.01                 | 0.03 | 0.03 | 54                 | μΑ   |
|           |                   | Quiescent                     | 4.00 | 4.95                          | 5.54 | 0.48               | 4.70 | 3.99  | 5.59 | 0.48               | 4.02                 | 4.98 | 5.63 | 0.48               | mA   |
|           | PVDD              | Software master<br>power-down | 0.01 | 0.03                          | 0.03 | N/A                | 0.01 | 0.03  | 0.03 | N/A                | 0.01                 | 0.03 | 0.03 | N/A                | μA   |
|           |                   | Auto power-down               | 310  | 310                           | 316  | N/A                | 310  | 310   | 316  | N/A                | 310                  | 310  | 316  | N/A                | μΑ   |
|           |                   | Quiescent                     | 4.60 | 5.60                          | 6.17 | N/A                | 4.60 | 5.65  | 6.35 | N/A                | 4.60                 | 5.60 | 6.40 | N/A                | mA   |

## Table 2. Power Supply Current Consumption<sup>1</sup>

<sup>1</sup> N/A means not applicable.

#### Table 3. Power-Down Current

| Parameter          | Symbol            | Test Conditions/Comments  | Min | Тур | Max | Unit |
|--------------------|-------------------|---|-----|-----|-----|------|
| POWER-DOWN CURRENT |                   | VREG18/DVDD = 1.8 V external, software master power-down, no BCLK/FSYNC |     |     |     |      |
|                    | PVDD              | $PV_{DD} = 5 V$   | 27  | 38  | 95  | nA   |
|                    |                   | $PV_{DD} = 12 V$  | 30  | 39  | 100 | nA   |
|                    |                   | $PV_{DD} = 17 V$  | 30  | 39  | 152 | nA   |
|                    | I <sub>DVDD</sub> | VREG18/DVDD = $1.8$ V external  |     | 7   | 27  | μA   |

#### Table 4. Digital Input/Output

| Parameter                          | Min               | Тур Мах | Unit  | Test Comments/Comments |
|------------------------------------|-------------------|---------|-------|------------------------|
| INPUT VOLTAGE <sup>1</sup>         |                   |         |       |                        |
| High (V <sub>⊮</sub> )             |                   |         |       |                        |
| BCLK, FSYNC, SCL, SDA              | 1.13              | 5.5     | V     |                        |
| SDATA, ADDR                        | 0.7 × VREG18/DVDD | 1.98    | V     |                        |
| Low (V <sub>L</sub> )              |                   |         |       |                        |
| BCLK, FSYNC, SDATA, SCL, SDA       | -0.3              | +0.54   | V     |                        |
| ADDR                               | -0.3              | +1.98   | V     |                        |
| INPUTLEAKAGE                       |                   |         |       |                        |
| High (I <sub>⊪</sub> )             |                   | 1       | μΑ    |                        |
| Low (I⊾)                           |                   | 1       | μΑ    |                        |
| INPUT CAPACITANCE                  |                   | 5       | pF    |                        |
| OUTPUT VOLTAGE (SDATA)             |                   |         |       |                        |
| High (V <sub>он</sub> )            | 1.17              |         | V     |                        |
| Low (V <sub>OL</sub> )             |                   | 0.45    | V     |                        |
| OUTPUT DRIVE STRENGTH <sup>1</sup> |                   |         |       |                        |
| SDA                                | 3                 | 5       | mA    |                        |
| SDATA                              | 2                 | 24      | mA    |                        |
| BCLK Frequency (BCLK)              | 2.048             | 24.57   | 6 MHz |                        |
| Sample Rate (FSYNC)                | 8                 | 192     | kHz   |                        |

<sup>1</sup> The pull-up resistor for SCL and SDA must be scaled according to the external pull-up voltage in the system. The typical value for a pull-up resistor for 1.8 V is 2.2 kΩ.

## DIGITAL TIMING CHARACTERISTICS

All timing specifications are given for the default setting (I<sup>2</sup>S mode) of the serial input port.

## Table 5. I<sup>2</sup>C Port Timing

|                         |     | Limit |      |  |
|-------------------------|-----|-------|------|--|
| Parameter               | Min | Max   | Unit | Description  |
| I <sup>2</sup> C PORT   |     |       |      |  |
| <b>f</b> <sub>SCL</sub> |     | 400   | kHz  | SCL frequency  |
| t <sub>SCLH</sub>       | 0.6 |       | μs   | SCL high   |
| t <sub>SCLL</sub>       | 1.3 |       | μs   | SCL low  |
| t <sub>SCS</sub>        | 0.6 |       | μs   | Setup time; relevant for repeated start condition          |
| t <sub>sCH</sub>        | 0.6 |       | μs   | Hold time; after this period, the first clock is generated |
| t <sub>DS</sub>         | 100 |       | ns   | Data setup time  |
| t <sub>SCR</sub>        |     | 300   | ns   | SCL rise time  |
| t <sub>SCF</sub>        |     | 300   | ns   | SCL fall time  |
| t <sub>R</sub>          |     | 300   | ns   | SDA rise time, not shown in Figure 2                       |
| t <sub>F</sub>          |     | 300   | ns   | SDA fall time, not shown in Figure 2                       |
| t <sub>BFT</sub>        | 0.6 |       | μs   | Bus-free time (time between stop and start)                |
| t <sub>HOLD</sub>       |     | 140   | ns   | SCL falling to SDA rising                                  |
|                         | 0   |       | ns   | SCL falling to SDA falling                                 |

## Table 6. Digital Input Timing

|                  |                  | Limit            |      |                                   |
|------------------|------------------|------------------|------|-----------------------------------|
| Parameter        | T <sub>MIN</sub> | T <sub>MAX</sub> | Unit | Description                       |
| SERIAL PORT      |                  |                  |      |                                   |
| t <sub>BIL</sub> | 15               |                  | ns   | BCLK low pulse width              |
| t <sub>BIH</sub> | 15               |                  | ns   | BCLK high pulse width             |
| t <sub>SIS</sub> | 6                |                  | ns   | SDATA setup, time to BCLK rising  |
| t <sub>siH</sub> | 6                |                  | ns   | SDATA hold, time from BCLK rising |
| t⊔s              | 10               |                  | ns   | FSYNC setup time to BCLK rising   |
| t <sub>uн</sub>  | 5                |                  | ns   | FSYNC hold time to BCLK rising    |
| t <sub>BP</sub>  | 40               |                  | ns   | Minimum BCLK period               |

# Digital Timing Diagrams

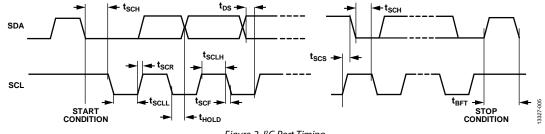


Figure 2. PC Port Timing

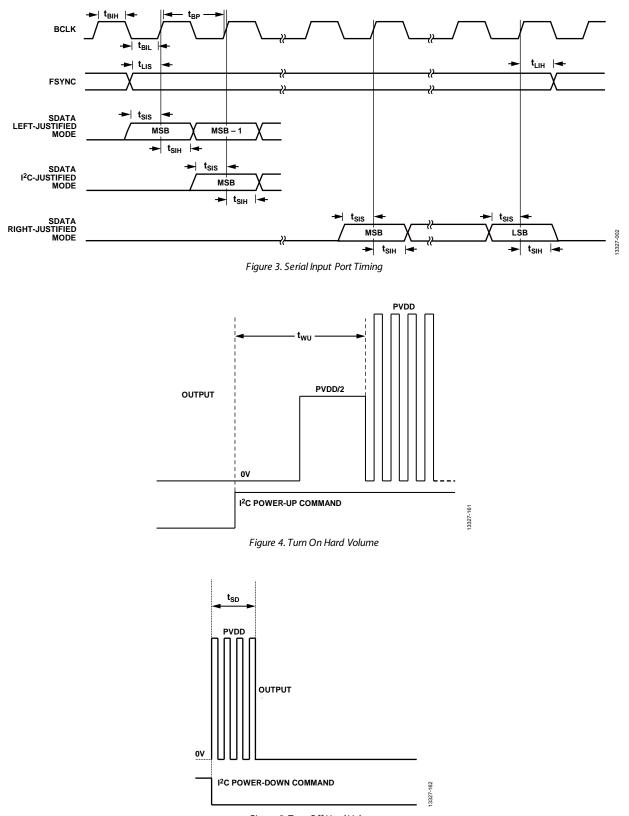


Figure 5. Turn Off Hard Volume

# **ABSOLUTE MAXIMUM RATINGS**

Absolute maximum ratings apply at  $T_A = 25$  °C, unless otherwise noted.

#### Table 7.

| Parameter                                     | Rating            |
|---|-------------------|
| PVDD Supply Voltage                           | –0.3 V to +18 V   |
| VREG18/DVDD Supply Voltage                    | –0.3 V to +1.98 V |
| VREG50/AVDD Supply Voltage                    | –0.3 V to +5.5 V  |
| PGND and AGND Differential                    | ±0.3 V            |
| ADDR, SDATA Input Voltage                     | –0.3 V to +1.98 V |
| SCL, SDA, BCLK, FSYNC Input Voltage           | –0.3 V to +5.5 V  |
| REG_EN Input Voltage                          | –0.3 V to +18 V   |
| Storage Temperature Range                     | –65℃ to +150℃     |
| Operating Temperature Range                   | −40°C to +85°C    |
| Junction Temperature Range                    | –65℃ to +165℃     |
| Lead Temperature Range<br>(Soldering, 60 sec) | 300℃              |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## THERMAL RESISTANCE

 $\theta_{JA}$  (junction to air) is specified for worst case conditions, that is, a device soldered in a circuit board for surface-mount packages.  $\theta_{JA}$ and  $\theta_{JB}$  are determined according to JESD51-9 on a 4-layer printed circuit board (PCB) with natural convection cooling.

#### Table 8. Thermal Resistance

| Package Type                   | θ <sub>JA</sub> | Unit |
|--------------------------------|-----------------|------|
| 20-Ball, 1.8 mm × 2.2 mm WLCSP | 55.5            | °C/W |

## **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

# **PIN CONFIGURATION AND FUNCTION DESCRIPTIONS**

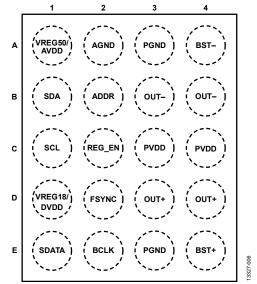


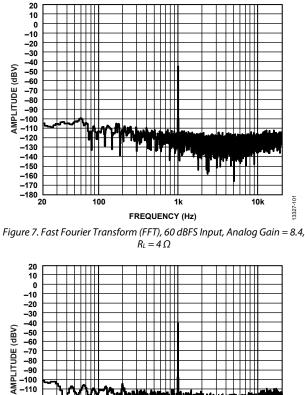
Figure 6. Pin Configuration (Top Side View)

# Table 9. Pin Function Descriptions

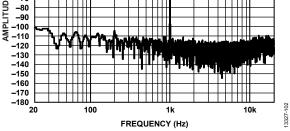
| Pin No. | Mnemonic    | Type <sup>1</sup> | Description  |
|---------|-------------|-------------------|--|
| A1      | VREG50/AVDD | AOUT              | 5 V Regulator Output.  |
| A2      | AGND        | PWR               | Analog Ground. It is recommended to connect the AGND pin to a single ground plane on the board.                                  |
| A3      | PGND        | PWR               | Power Stage Ground. The PGND pin is shorted internally. It is recommended to connect PGND to a single ground plane on the board. |
| A4      | BST-        | AIN               | Bootstrap Capacitor for OUT  |
| B1      | SDA         | DIO               | I <sup>2</sup> C Serial Data.  |
| B2      | ADDR        | DIN               | I <sup>2</sup> C Address Selection.  |
| B3      | OUT-        | AOUT              | Power Stage Inverting Output.  |
| B4      | OUT-        | AOUT              | Power Stage Inverting Output.  |
| C1      | SCL         | DIN               | I <sup>2</sup> C Clock.  |
| C2      | REG_EN      | AIN               | Regulator Enable Tie to PVDD to Enable Regulators.   |
| C3      | PVDD        | PWR               | Power Stage Supply.  |
| C4      | PVDD        | PWR               | Power Stage Supply.  |
| D1      | VREG18/DVDD | PWR               | 1.8 V Regulator Output/DVDD Input.   |
| D2      | FSYNC       | DIN               | TDM Frame Sync Input.  |
| D3      | OUT+        | AOUT              | Power Stage Noninverting Output.   |
| D4      | OUT+        | AOUT              | Power Stage Noninverting Output.   |
| E1      | SDATA       | DIO               | Serial Data Input to DAC.  |
| E2      | BCLK        | DIN               | TDM Bit Clock Input.   |
| E3      | PGND        | PWR               | Power Stage Ground. The PGND pin is shorted internally. It is recommended to connect PGND to a single ground plane on the board. |
| E4      | BST+        | AIN               | Bootstrap Capacitor for OUT+.  |

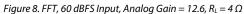
<sup>1</sup> AOUT is analog output; PWR is power supply or ground pin; AIN is analog input; DIO is digital input/output; DIN is digital input.

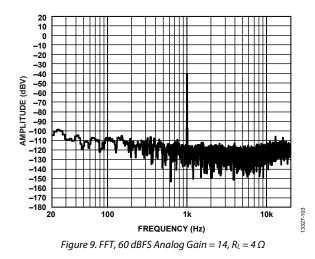
# **TYPICAL PERFORMANCE CHARACTERISTICS**

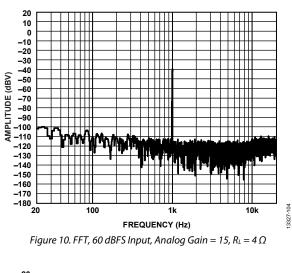


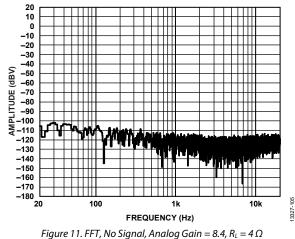
13327-101

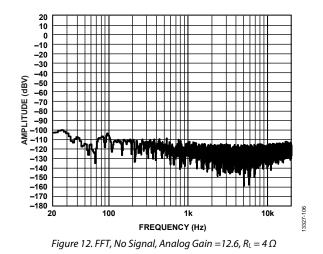












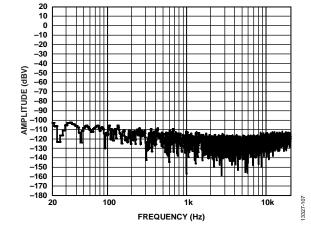


Figure 13. FFT, No Signal, Analog Gain = 14,  $R_L = 4 \Omega$ 

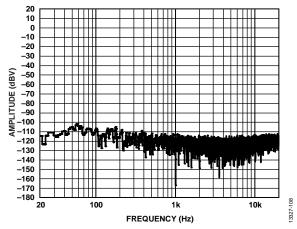


Figure 14. FFT, No Signal, Analog Gain = 15,  $R_L$  = 4  $\Omega$ 

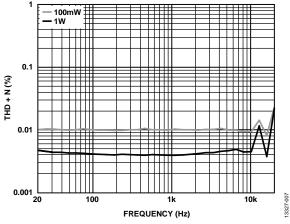


Figure 15. THD + N vs. Frequency into  $R_L = 4 \Omega$ ,  $PV_{DD} = 4.5 V$ 

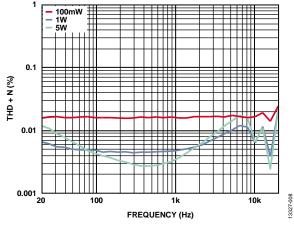


Figure 16. THD + N vs. Frequency,  $R_L = 4 \Omega$ ,  $PV_{DD} = 12 V$ 

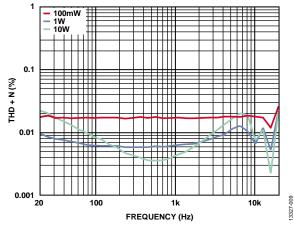


Figure 17. THD + N vs. Frequency,  $R_L = 4 \Omega$ ,  $PV_{DD} = 17 V$ 

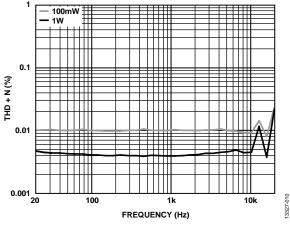


Figure 18. THD + N vs. Frequency,  $R_L = 8 \Omega$ ,  $PV_{DD} = 4.5 V$ 

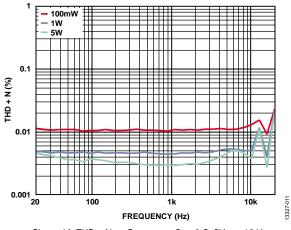


Figure 19. THD + N vs. Frequency,  $R_L = 8 \Omega$ ,  $PV_{DD} = 12 V$ 

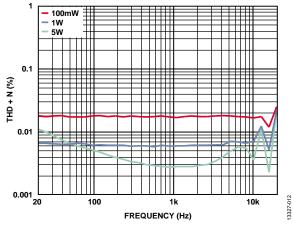


Figure 20. THD + N vs. Frequency,  $R_L = 8 \Omega$ ,  $PV_{DD} = 17 V$ 

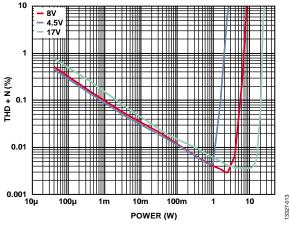


Figure 21. THD + N vs. Output Power,  $R_L = 4 \Omega$ , Analog Gain = 8.4

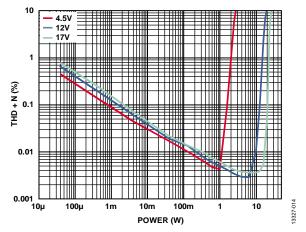
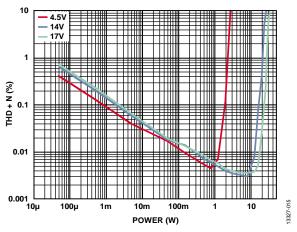
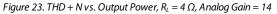


Figure 22. THD + N vs. Output Power,  $R_L = 4 \Omega$ , Analog Gain = 12.6





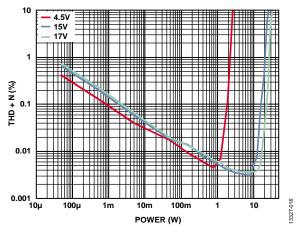


Figure 24. THD + N vs. Output Power,  $R_L = 4 \Omega$ , Analog Gain = 15

# $\begin{array}{c} 10 \\ 0.01 \\ 0.001 \\ 0.$

Figure 25. THD + N vs. Output Power,  $R_L = 8 \Omega$ , Analog Gain = 8.4

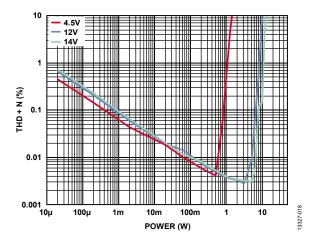


Figure 26. THD + N vs. Output Power,  $R_L = 8 \Omega$ , Analog Gain = 12.6

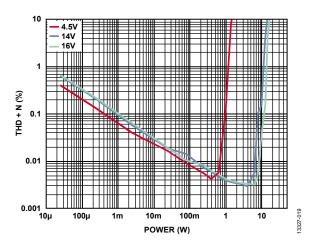


Figure 27. THD + N vs. Output Power,  $R_L = 8 \Omega$ , Analog Gain = 14

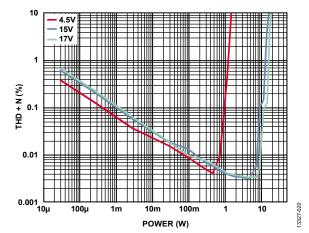


Figure 28. THD + N vs. Output Power,  $R_L = 8 \Omega$ , Analog Gain = 15

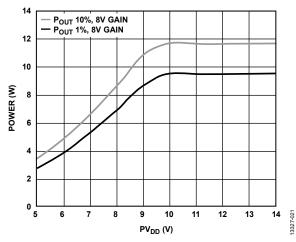


Figure 29. Output Power vs. PVDD Supply Voltage ( $PV_{DD}$ ),  $R_L = 4 \Omega$ , Analog Gain = 8.4

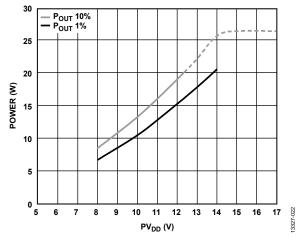
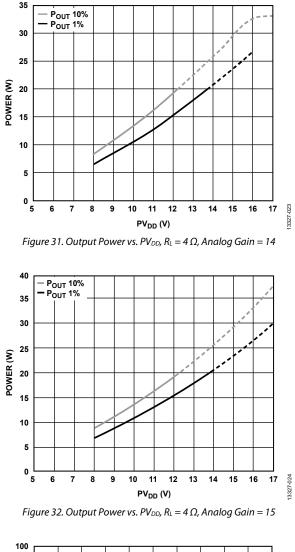
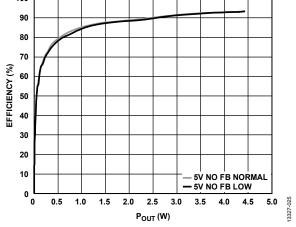
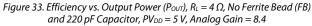


Figure 30. Output Power vs.  $PV_{DD}$ ,  $R_L = 4 \Omega$ , Analog Gain = 12.6







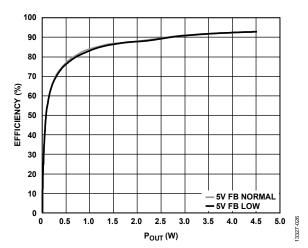


Figure 34. Efficiency vs.  $P_{OUT}$ ,  $R_L = 4 \Omega$ , FB and 220 pF Capacitor,  $PV_{DD} = 5 V$ , Analog Gain = 8.4

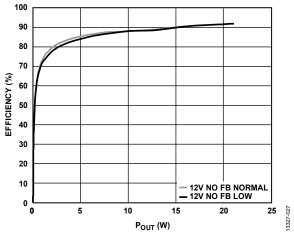


Figure 35. Efficiency vs.  $P_{OUT}$ ,  $R_L = 4 \Omega$ , No FB and 220 pF,  $PV_{DD} = 12 V$ , Analog Gain = 12.6

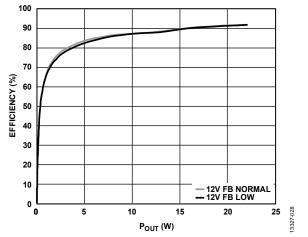


Figure 36. Efficiency vs.  $P_{OUT}$ ,  $R_L = 4 \Omega$ , FB and 220 pF Capacitor,  $PV_{DD} = 12 V$ , Analog Gain = 12.6

#### 100 90 80 70 EFFICIENCY (%) 60 50 40 30 20 10 17V FB NORMAL 17V FB LOW 0 -029 0 5 10 15 20 25 30 35 40 3327. P<sub>OUT</sub> (W)

Figure 37. Efficiency vs.  $P_{OUT}$ ,  $R_L = 4 \Omega$ , FB and 220 pF Capacitor,  $PV_{DD} = 17 V$ , Analog Gain = 14

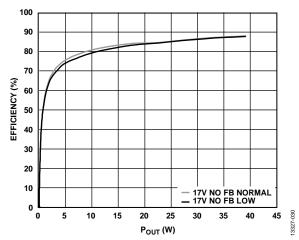


Figure 38. Efficiency vs.  $P_{OUT}$ ,  $R_L = 4 \Omega$ , No FB and 220 pF Capacitor,  $PV_{DD} = 17 V$ , Analog Gain = 14

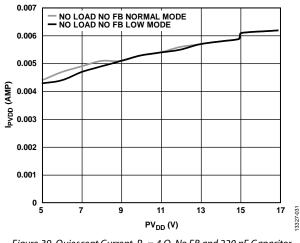


Figure 39. Quiescent Current,  $R_L = 4 \Omega$ , No FB and 220 pF Capacitor, Analog Gain = 12

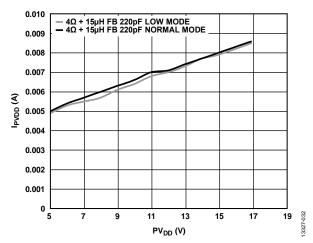
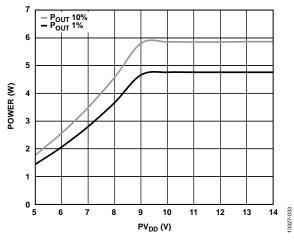
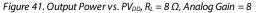


Figure 40. Quiescent Current,  $R_L = 4 \Omega$ , FB and 220 pF Capacitor, Analog Gain = 12





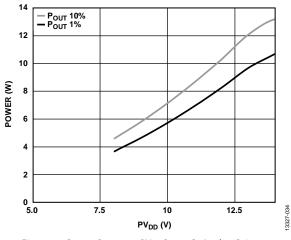


Figure 42. Output Power vs.  $PV_{DD}$ ,  $R_L = 8 \Omega$ , Analog Gain = 12

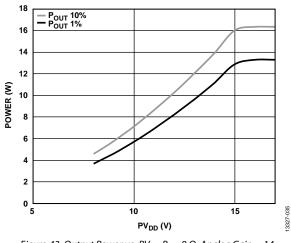


Figure 43. Output Power vs.  $PV_{DD}$ ,  $R_L = 8 \Omega$ , Analog Gain = 14

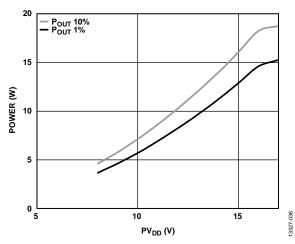


Figure 44. Output Power vs.  $PV_{DD}$ ,  $R_L = 8 \Omega$ , Analog Gain = 15

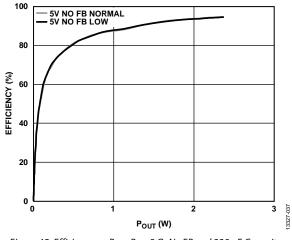


Figure 45. Efficiency vs.  $P_{OUT}$ ,  $R_L = 8 \Omega$ , No FB and 220 pF Capacitor,  $PV_{DD} = 5 V$ , Analog Gain = 8.4

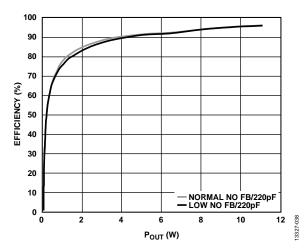


Figure 46. Efficiency vs.  $P_{OUT}$ ,  $R_L = 8 \Omega$ , No FB and 220 pF Capacitor,  $PV_{DD} = 12 V$ , Analog Gain = 12.6

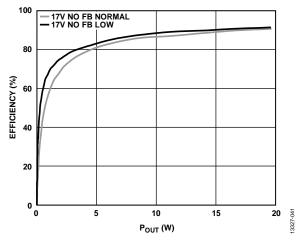
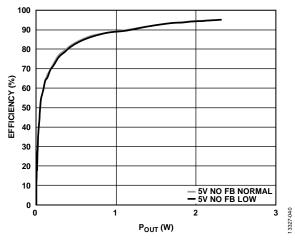
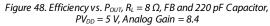
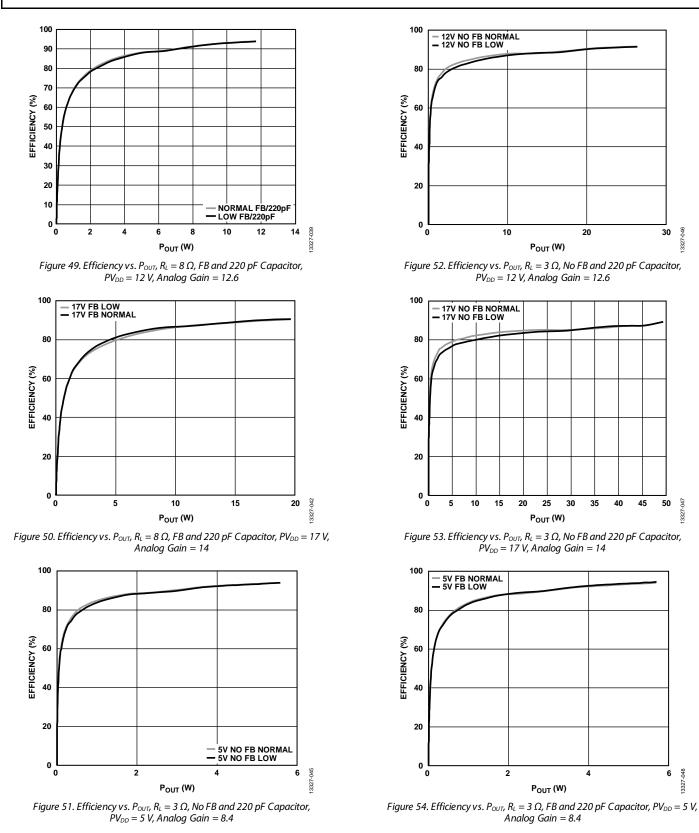


Figure 47. Efficiency vs.  $P_{OUT}$ ,  $R_L = 8 \Omega$ , No FB and 220 pF Capacitor,  $PV_{DD} = 17$  V, Analog Gain = 14







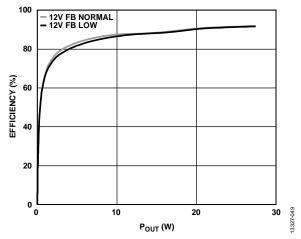


Figure 55. Efficiency vs.  $P_{OUT}$ ,  $R_L = 3 \Omega$ , FB and 220 pF Capacitor,  $PV_{DD} = 12 V$ , Analog Gain = 12.6

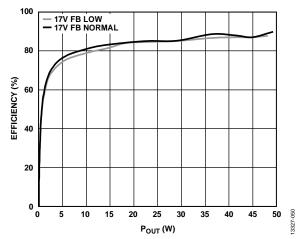


Figure 56. Efficiency vs.  $P_{OUT,r}$ ,  $R_L = 3 \Omega$ , FB and 220 pF Capacitor,  $PV_{DD} = 17 V$ , Analog Gain = 14

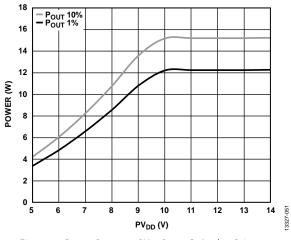


Figure 57. Output Power vs.  $PV_{DD}$ ,  $R_L = 3 \Omega$ , Analog Gain = 8.4

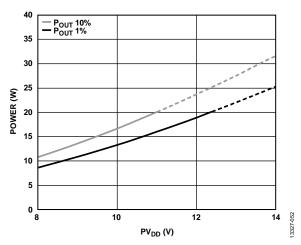
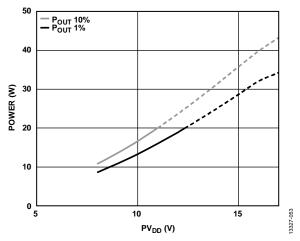
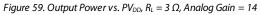


Figure 58. Output Power vs.  $PV_{DD}$ ,  $R_L = 3 \Omega$ , Analog Gain = 12.6





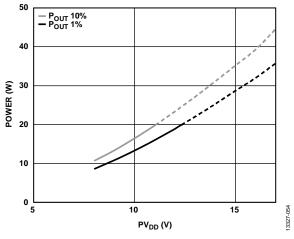


Figure 60. Output Power vs.  $PV_{DD}$ ,  $R_L = 3 \Omega$ , Analog Gain = 15

# THEORY OF OPERATION overview

The SSM3515 Class-D audio amplifier features a filterless modulation scheme that greatly reduces the external component count, conserving board space and reducing system cost. The SSM3515 does not require an output filter, it relies on the inherent inductance of the speaker coil and the natural filtering of the speaker and human ear to recover the audio component of the square wave output.

Most Class-D amplifiers use some variation of pulse-width modulation (PWM), but the SSM3515 uses  $\Sigma$ - $\Delta$  modulation to determine the switching pattern of the output devices, resulting in a number of important benefits.  $\Sigma$ - $\Delta$  modulators do not produce a sharp peak with many harmonics in the AM broadcast band, as pulse-width modulators often do.  $\Sigma$ - $\Delta$  modulation reduces the amplitude of spectral components at high frequencies, reducing EMI emission that may otherwise be radiated by speakers and long cable traces. Due to the inherent spread spectrum nature of  $\Sigma$ - $\Delta$  modulation, the need for oscillator synchronization is eliminated for designs incorporating multiple SSM3515 amplifiers.

The SSM3515 also integrates overcurrent and temperature protection and a thermal warning with optional programmable gain reduction.

## **POWER SUPPLIES**

The power supply pins on the SSM3515 are PVDD, VREG50/AVDD, and VREG18/DVDD.

PVDD, the battery supply, is used for the output stage and also supplies power to the 5 V regulator. In addition, it can be used to supply power to the 1.8 V regulator. This pin must be decoupled to ground using a 100 nF capacitor in parallel with a 1  $\mu$ F MLCC capacitor to ground as close as possible to the respective pins. In addition, a bulk electrolytic capacitor may be required depending on the output power to supply the current at low frequency output. Typically, 220  $\mu$ F and 25 V is recommended. This must be sized according to the power supply regulation in the system.

VREG50/AVDD (5 V) is the analog supply used for the input stage, modulator, power stage driver, and other blocks. It uses the VREG50/AVDD pin. It is generated internally by the integrated 5 V linear regulator. This pin must be decoupled to ground using the 100 nF and 10  $\mu F$  capacitor.

VREG18/DVDD (1.8 V) is the supply for the digital circuitry. It uses the VREG18/DVDD pin. It can be generated internally using an integrated 1.8 V linear regulator. Alternatively, an external 1.8 V supply can be used to save the power dissipation. The VREG18/DVDD pin must be decoupled to ground using 100 nF and 10 µF MLCC capacitors close to the pin.

# **POWER-UP SEQUENCE**

If the REG\_EN pin is tied to PVDD, the power-up sequence is performed internally. As the PVDD voltage ramps up, the VREG18/DVDD voltage (generated internally) also ramps up. The typical wait time before the I<sup>2</sup>C commands can be sent to the device depends on the PVDD supply ramp-up time.

If the REG\_EN pin is tied low, ensure that 1.8 V is supplied externally and that  $PV_{\rm DD}$  is greater than 4.5 V before sending  $I^2C$  commands to enable the device.

## **POWER-DOWN OPERATION**

The SSM3515 offers several power down options via I<sup>2</sup>C. Register 0x00 provides multiple options for setting the various power-down modes.

Set the SPWDN bit to 1 to fully power down the device. Only the I<sup>2</sup>C, 1.8 V regulator is kept alive.

The SSM3515 monitors both the BCLK and FSYNC pins for clock presence when in 2-wire mode. When no BCLK or FSYNC signals are present, the device automatically powers down all internal circuitry to its lowest power state. When a BCLK or FSYNC signal returns, the device automatically powers up following its usual power up sequence.

When enabled, the APWDN\_EN bit (auto power down), activates a low power state as soon as 2048 consecutive zero input samples are received. Only the I<sup>2</sup>C and digital audio input blocks are kept active.

# **REG\_EN PIN SETUP AND CONTROL**

The REG\_EN (regulator enable) pin enables or disables the internal 1.8 V regulator.

#### Table 10. Regulator Enable Pin Function

| REG_EN | 1.8 V Regulator | Comment        |
|--------|-----------------|----------------|
| Ground | Disabled        | External 1.8 V |
| PVDD   | Enabled         | Internal 1.8 V |

The status of the REG\_EN pin determines if the 1.8 V supply is generated internally or if it must be provided externally. If the REG\_EN pin is tied to PVDD, the internal 1.8 V regulator is enabled. If the REG\_EN pin is tied to ground, a 1.8 V supply must be supplied externally to the VREG18/DVDD pin for the device to operate. For the device to respond to I<sup>2</sup>C commands, the 1.8 V supply must be stable.

## ADDR PIN SETUP AND CONTROL

The ADDR pin sets the device I<sup>2</sup>C address. See Table 11 for details.

## CLOCKING

In 3-wire mode (BCLK, FSYNC, SDATA), a BCLK signal must be provided to the SSM3515 for correct operation. The BCLK

#### Table 11. Pin Setup List

signal must have a minimum frequency of 2.048 MHz. The BCLK signal is used for internal clocking of the device. The BCLK rate is detected automatically, but the sampling frequency must be known to the device. The supported BCLK rates at 32 kHz to 48 kHz are 50, 64, 100, 128, 192, 200, 256, 384, 400, and 512 times the sample rate.

| ADDR Pin   | SCL Pin | SDA Pin | Control Mode     | 7-Bit I <sup>2</sup> C Address | TDM Slot |
|--|---------|---------|------------------|--------------------------------|----------|
| Connected to Ground Using a 47 k $\Omega$ Resistor | SCL     | SDA     | I <sup>2</sup> C | 0x14                           | 1        |
| Open (No Connection)                               | SCL     | SDA     | I <sup>2</sup> C | 0x15                           | 2        |
| Connected to 1.8 V Using a 47 k $\Omega$ Resistor  | SCL     | SDA     | I <sup>2</sup> C | 0x16                           | 3        |
| Connected to 1.8 V                                 | SCL     | SDA     | I <sup>2</sup> C | 0x17                           | 4        |

# **DIGITAL AUDIO SERIAL INTERFACE**

The SSM3515 includes a standard serial audio interface that is slave only. The interface is capable of receiving I<sup>2</sup>S, left justified, PCM, or TDM formatted data.

The serial interface has three main operating modes, listed in Table 12.

## Table 12. Operating Modes

| Mode               | Format                          | Comments  |
|--------------------|---------------------------------|---|
| 2-Channel (Stereo) | I <sup>2</sup> S/left justified | Register control<br>using I <sup>2</sup> C port |
| Multichannel TDM   | l <sup>2</sup> S/left justified | Register control<br>using I <sup>2</sup> C port |

Stereo modes, typically I<sup>2</sup>S or left justified, are used when there is one or two devices on the interface bus. Standard multichannel TDM modes are more flexible and offer the ability to have multiple devices on the bus. In both of these cases, the register control uses an I<sup>2</sup>C port.

# STEREO (I<sup>2</sup>S/LEFT JUSTIFIED) OPERATING MODE

Stereo modes use both edges of FSYNC to determine placement of data. Stereo mode is enabled when SAI\_MODE = 0 and the data format is determined by the SDATA\_FMT register setting.

The I<sup>2</sup>S or left justified interface formats accept any number of BCLK cycles per FSYNC cycle. Sample rates from 8 kHz to 192 kHz are accepted. The maximum BCLK rate is 24.576 MHz

## **TDM OPERATING MODE**

The TDM operating mode allows multiple chips to use a single serial interface bus for audio data.

The FSYNC signal operates at the desired sample rate. A rising edge of the FSYNC signal indicates the start of a new frame. For proper operation, this signal must be one BCLK cycle wide, transitioning on a falling BCLK edge. The MSB of data must be present on the SDATA one BCLK cycle later. The SDATA signal latches on the rising edge of BCLK.

Each chip on the TDM bus can occupy 16, 24, 32, 48, or 64 BCLK cycles. This is set with the TDM\_BCLKS bits and all devices on the bus must have the same setting. Up to 16 SSM3515 devices can be used on a single TDM bus, but only 4 unique I<sup>2</sup>C device addresses are available. The SSM3515 automatically determines how many possible devices can be placed on the bus from the BCLK rate. There is no limit to the total number of BCLK cycles per FSYNC pulse.

Which chip slot each <u>SSM3515</u> uses is determined by the ADDR pin settings (see Table 11 for details), or by the TDM\_SLOT bits in Register 0x05.

The input data width to the DAC can be either 16-bit or 24-bit.

# I<sup>2</sup>C CONTROL

The SSM3515 supports a 2-wire serial (I<sup>2</sup>C-compatible) microprocessor bus driving multiple peripherals. Two pins, serial data (SDA) and serial clock (SCL), carry information between the SSM3515 and the system I<sup>2</sup>C master controller. The SSM3515 is always a slave on the bus, meaning it cannot initiate a data transfer. Each slave device is recognized by a unique address. Using the ADDR pin provides the four device addresses, which are listed in Table 11. The address byte format is shown in Table 13. The address resides in the first seven bits of the I<sup>2</sup>C write. The LSB of this byte sets either a read or write operation. Logic Level 1 corresponds to a read operation, and Logic Level 0 corresponds to a write operation.

Connect 2.2 k $\Omega$  pull-up resistors on the lines connected to the SDA and SCL pins. The voltage on these signal lines must not be more than 5 V.

## Addressing

Initially, each device on the I<sup>2</sup>C bus is in an idle state, monitoring the SDA and SCL lines for a start condition and the proper address. The I<sup>2</sup>C master initiates a data transfer by establishing a start condition, defined by a high to low transition on SDA while SCL remains high. This indicates that an address or data stream follows. All devices on the bus respond to the start condition and shift the next eight bits (the 7-bit address plus the R/W bit) MSB first. The device that recognizes the transmitted address responds by pulling the data line low during the ninth clock pulse. This ninth bit is an acknowledge bit. All other devices withdraw from the bus at this point and return to the idle condition. The device address for the SSM3515 is determined by the state of the ADDR pin. See Table 11 for four available addresses.

The R/W bit determines the direction of the data. A Logic 0 on the LSB of the first byte means the master writes information to the peripheral, whereas a Logic 1 means the master reads information from the peripheral after writing the subaddress and repeating the start address. A data transfer occurs until a stop condition is encountered. A stop condition occurs when SDA transitions from low to high while SCL is held high. The timing for the I<sup>2</sup>C port is shown in Figure 61.

Stop and start conditions can be detected at any stage during the data transfer. If these conditions are asserted out of sequence with normal read and write operations, the SSM3515 immediately jumps to the idle condition. During a given SCL high period, the user must issue only one start condition, one stop condition, or a single stop condition followed by a single start condition. If the user issues an invalid subaddress, the SSM3515 does not issue an acknowledge and returns to the idle condition. If the user exceeds the highest subaddress while in auto-increment mode, one of two actions is taken.

In read mode, the SSM3515 outputs the highest subaddress register contents until the master device issues a no acknowledge, indicating the end of a read. A no acknowledge condition is when the SDA line is not pulled low on the ninth clock pulse on SCL. If the highest subaddress location is reached while in write mode, the data for the invalid byte is not loaded into any subaddress register, a no acknowledge is issued by the SSM3515, and the device returns to the idle condition.

## I<sup>2</sup>C Read and Write Operations

Figure 62 shows the timing of a single-word write operation. Every ninth clock, the SSM3515 issues an acknowledge (ACK) by pulling SDA low.

Figure 63 shows the timing of a burst mode write sequence. This figure shows an example in which the target destination registers are two bytes. The <u>SSM3515</u> increments its subaddress register

every byte because the requested subaddress corresponds to a register or memory area with a byte word length.

The timing of a single word read operation is shown in Figure 64. Note that the first R/W bit is 0, indicating a write operation. This is because the subaddress still must be written to set up the internal address. After the SSM3515 acknowledges the receipt of the subaddress, the master must issue a repeated start command followed by the chip address byte with the R/W set to 1 (read). This causes the SSM3515 SDA to reverse and begin driving data back to the master. The master then responds every ninth pulse with an acknowledge pulse to the SSM3515. See Table 15 for a list of abbreviations in Figure 62 through Figure 65.

#### Table 13. I<sup>2</sup>C Device Address Byte Format Using the ADDR Pin<sup>1</sup>

| Bit 0 | Bit 1 | Bit 2 | Bit 3 | Bit 4 | Bit 5 | Bit 6 | Bit 7 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| 0     | 0     | 1     | 0     | 1     | Х     | Х     | R/W   |

<sup>1</sup> X means don't care.

#### Table 14. ADDR Pin to I<sup>2</sup>C Device Address Mapping

| ADDR Pin                 | ADDR Voltage       | I <sup>2</sup> C Address Bit 5 | I <sup>2</sup> C Address Bit 6 |
|--------------------------|--------------------|--------------------------------|--------------------------------|
| GND                      | GND                | Not applicable                 | Not applicable                 |
| Pull-Down 47 kΩ Resistor | 0.25 × VREG18/DVDD | 0                              | 0                              |
| Open                     | 0.5 × VREG18/DVDD  | 0                              | 1                              |
| Pull-Up 47 kΩ Resistor   | 0.75 × VREG18/DVDD | 1                              | 0                              |
| DVDD                     | DVDD               | 1                              | 1                              |

#### Table 15. Abbreviations for Figure 62 Through Figure 65

| Symbol         | Meaning               |
|----------------|-----------------------|
| S              | Start bit             |
| Р              | Stop bit              |
| A <sub>M</sub> | Acknowledge by master |
| As             | Acknowledge by slave  |

#### SSM3515 ... SCK į R/W АСК SDA ACK START BY MASTER FRAME 2 SUBADDRESS BYTE FRAME 1 CHIP ADDRESS BYTE SCK (CONTINUED) İ ł SDA (CONTINUED) АСК ACK STOP BY MASTER 13327-066 FRAME 3 DATA BYTE 1 FRAME 4 DATA BYTE 2 Figure 61. I<sup>2</sup>C Read/Write Timing

| START I <sup>2</sup> | C ADDRESS<br>(7 BITS) | R/W = 0 | ACK BY<br>SLAVE | SUBADDRESS<br>(8 BITS) | ACK BY<br>SLAVE | DATA BYTE 1<br>(8 BITS) | STOP<br>BIT | 13327-067 |
|----------------------|-----------------------|---------|-----------------|------------------------|-----------------|-------------------------|-------------|-----------|
|----------------------|-----------------------|---------|-----------------|------------------------|-----------------|-------------------------|-------------|-----------|

Figure 62. Single Word I<sup>2</sup>C Write Format

| s | CHIP ADDRESS,<br>R/W = 0 | A <sub>S</sub> | SUBADDRESS | As | DATA<br>WORD 1 | A <sub>S</sub> | DATA<br>WORD 2 | A <sub>S</sub> | .: | Ρ | 13327-068 |
|---|--------------------------|----------------|------------|----|----------------|----------------|----------------|----------------|----|---|-----------|
|   |                          |                |            |    |                |                |                |                |    |   |           |

Figure 63. Burst Mode I<sup>2</sup>C Write Format

|  | s | CHIP ADDRESS,<br>R/W = 0 | As | SUBADDRESS | A <sub>S</sub> | s | CHIP ADDRESS,<br>R/W = 1 | As | DATA<br>BYTE 1 | A <sub>M</sub> | DATA<br>BYTE N | Р | 000 20004 |
|--|---|--------------------------|----|------------|----------------|---|--------------------------|----|----------------|----------------|----------------|---|-----------|
|--|---|--------------------------|----|------------|----------------|---|--------------------------|----|----------------|----------------|----------------|---|-----------|

Figure 64. Single Word I<sup>2</sup>C Read Format

| s | CHIP ADDRESS,<br>R/W = 0 | As | SUBADDRESS | As | s | CHIP ADDRESS,<br>R/W = 1 | A <sub>S</sub> | DATA<br>WORD 1 | A <sub>M</sub> |  | Р | 13327-070 |
|---|--------------------------|----|------------|----|---|--------------------------|----------------|----------------|----------------|--|---|-----------|
|---|--------------------------|----|------------|----|---|--------------------------|----------------|----------------|----------------|--|---|-----------|

Figure 65. Burst Mode I<sup>2</sup>C Read Format

## ANALOG AND DIGITAL GAIN

Several selectable settings are available for the analog gain of the system. These provide optimal gain settings at various PVDD supply voltages. The ANA\_GAIN bits are available in Register 0x01, Bits[1:0].

The available options are as shown in Table 16.

#### Table 16. Analog Gain Options

| PVDD         | ANA_GAIN | Amplifier Analog Gain<br>Selection |
|--------------|----------|------------------------------------|
| 5 V to 9 V   | 00       | 8.4 V full-scale gain mapping      |
| 9 V to 13 V  | 01       | 12.6 V full-scale gain mapping     |
| 13 V to 14 V | 10       | 14 V full-scale gain mapping       |
| 14 V to 16 V | 11       | 15 V full-scale gain mapping       |

There is also a digital gain or volume control that provides fine control in 0.375 dB steps from -70 dB to +24 dB.

## POP AND CLICK SUPPRESSION

Voltage transients at the output of audio amplifiers may occur when shutdown is activated or deactivated. Voltage transients as small as 10 mV can be heard as an audible pop in the speaker. Clicks and pops are defined as undesirable audible transients generated by the amplifier system that do not come from the system input signal.

Such transients may be generated when the amplifier system changes its operating mode. For example, system power-up and power-down can be sources of audible transients.

The SSM3515 has a pop and click suppression architecture that reduces these output transients, resulting in noiseless activation and deactivation.

Either mute or power-down must be set before the BCLK is removed to ensure a pop free power-down.

# **EMI NOISE**

The SSM3515 uses a proprietary modulation and spread spectrum technology to minimize EMI emissions from the device. The SSM3515 can pass FCC Class B emissions testing with an unshielded 20-inch cable using ferrite bead-based filtering. For applications that have difficulty passing FCC Class B emission tests, the SSM3515 includes a modulation select pin (ultralow EMI emission mode) that significantly reduces the radiated emissions at the Class-D outputs, particularly above 100 MHz. Note that reducing the supply voltage greatly reduces radiated emissions.

## **OUTPUT MODULATION DESCRIPTION**

The SSM3515 uses three-level,  $\Sigma - \Delta$  output modulation. Each output can swing from GND to PV<sub>DD</sub> and vice versa. Ideally, when no input signal is present, the output differential voltage is 0 V because there is no need to generate a pulse. In a real-world situation, there are always noise sources present.

Due to this constant presence of noise, a differential pulse is occasionally generated in response to this stimulus. A small amount of current flows into the inductive load when the differential pulse is generated. However, most of the time, the output differential voltage is 0 V. This feature ensures that the current flowing through the inductive load is small.

When the user sends an input signal, an output pulse is generated to follow the input voltage. The differential pulse density is increased by raising the input signal level. Figure 66 depicts three-level,  $\Sigma$ - $\Delta$  output modulation with and without input stimulus.

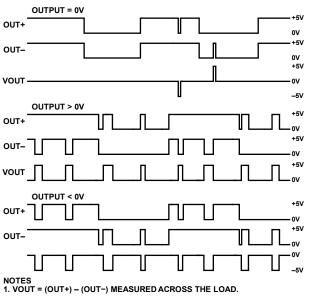


Figure 66. Three-Level,  $\Sigma$ - $\Delta$  Output Modulation With and Without Input Stimulus

## FAULTS AND LIMITER STATUS REPORTING

The SSM3515 offers comprehensive protections against the faults at the outputs and reporting to help with system design. The faults listed in Table 17 are reported using the status registers.

#### Table 17. Register 0x0A, Faults

| Fault Type             | Flag Set Condition                 | Status Reported<br>Register |
|------------------------|------------------------------------|-----------------------------|
| 5 V Regulator UV       | 5 V regulator voltage at           | Register 0x0A,              |
|                        | VREG50/AVDD < 3.6 V                | Bit 6, UVLO_VREG            |
| Limiter/Gain Reduction | Limiter engaged                    | Register 0x0A,              |
| Engage                 |                                    | Bit 5, LIM_EG               |
| Clipping               | DAC clipping                       | Register 0x0A,              |
|                        |                                    | Bit 4, CLIP                 |
| Output Overcurrent     | Output current >6 A                | Register 0x0A,              |
| (OC)                   | peak                               | Bit 3, AMP_OC               |
| Die Overtemperature    | Die temperature >                  | Register 0x0A,              |
| (OT)                   | 145℃                               | Bit 2, OTF                  |
| Die Overtemperature    | Die temperature >                  | Register 0x0A,              |
| Warning (OTW)          | 117℃                               | Bit 4, OTW                  |
| Battery Voltage >      | Battery voltage PV <sub>DD</sub> > | Register 0x0A,              |
| VBAT_INF               | VBAT_INF                           | Bit 0, BAT_WARN             |
|                        |                                    |                             |

The faults listed in Table 17 are reported in Register 0x0A and can be read via I<sup>2</sup>C by the microcontroller in the system.

In the event of a fault occurrence, how the device reacts to the faults can be controlled by using Register 0x0B.

|                          | •   | Status Reported                       |
|--------------------------|---|---------------------------------------|
| Fault Type               | Flag Set Condition  | Register                              |
| OTW                      | The amount of gain<br>reduction applied if there<br>is an OTW                             | Register 0x0B,<br>Bits[7:6], OTW_GAIN |
| Manual<br>Recovery       | Use to attempt manual<br>recovery in case of a fault<br>event                             | Register 0x0B, Bit 5,<br>MRCV         |
| Autorecovery<br>Attempts | When autorecovery from<br>faults is used, set the<br>number of attempts using<br>this bit | Register 0x0B,<br>Bits[4:3], MAX_AR   |
| UV                       | Recovery can be automatic<br>or manual  | Register 0x0B, Bit 2,<br>ARCV_UV      |
| Die OT                   | Recovery can be automatic<br>or manual  | Register 0x0B, Bit 1,<br>ARCV_OT      |
| OC                       | Recovery can be automatic<br>or manual  | Register 0x0B, Bit 0,<br>ARCV_OC      |

#### Table 18. Register 0x0B, Fault Recovery

When the automatic recovery mode is set, the device attempts to recover itself after the fault event and, in case the fault persists, then the device sets the fault again. This process repeats until the fault is resolved.

When the manual recovery mode is used, the device shuts down and the recovery must be attempted using the system microcontroller.

## **VBAT SENSING**

The SSM3515 contains an 8-bit ADC that measures the voltage of the battery voltage (VBAT) supply. The battery voltage information is stored in Register 0x06 as an 8-bit unsigned format. The ADC input range is fixed internally as 3.8 V to 16.2 V. To convert the hexidecimal (hex) value to the voltage value, use the following steps:

- 1. Convert the hex value to decimal. For example, if the hex value is 0xA9, the decimal value = 169.
- 2. Calculate the voltage using the following equation:

 $Voltage = 3.8 \text{ V} + 12.4 \text{ V} \times Decimal Value/255$ 

With a decimal value of 169,

*Voltage* = 3.8 V + 12.4 V × 169/255 = 12.02 V

# LIMITER AND BATTERY TRACKING THRESHOLD CONTROL

The SSM3515 contains an output limiter that can be used limit the peak output voltage of the amplifier. The limiter works on the rms and peak value of the signal. The limiter threshold, slope, attack rate, and release rate are programmable using Register 0x07, Register 0x08, and Register 0x09. The limiter can be enabled or disabled using LIM\_EN, Bits[1:0] in Register 0x07.

The threshold at which the output is limited is determined by the LIM\_THRES register setting, in Register 0x08, Bits[7:3]. When the ouput signal level exceeds the set therhold level, the limiter activates and limits the signal level to the set limit. Below the set threshold, the output level is not affected. The limiter threshold can be set from 1 V peak to 15 V peak.

The limiter threshold can be set above the maximum output voltage of the amplifier. In this case, the limiter allows maximum peak output; in other words, the output may clip depending on the power supply voltage and not the limiter.

The limiter threshold can be set as fixed or to vary with the battery voltage via the VBAT\_TRACK bit (Register 0x07, Bit 2). When set to fixed, the limiter threshold is fixed and does not vary with battery voltage. The threshold can be set from 1 V peak to 15 V peak using the LIM\_THRES bit (see Figure 68).

When set to a variable threshold, the SSM3515 monitors the VBAT supply and automatically adjusts the limiter threshold based on the VBAT supply voltage.

The VBAT supply voltage at which the limiter threshold level begins to decrease the output level is determined by the VBAT inflection point, the VBAT\_INF bits (Register 0x09, Bits[7:0]).

The VBAT\_INF point is defined as the battery voltage at which the limiter either activates or deactivates depending on the LIM\_EN mode (see Table 19). When the battery voltage is greater than VBAT\_INF, the limiter is not active. When it battery voltage is less than VBAT\_INF, the limiter is activated. The VBAT\_INF bits can be set from 3.8 V to 16.2 V. The 8-bit value for the voltage can be calculated using the following equation.

 $Voltage = 3.8 + 12.4 \times Decimal Value/255$ 

Convert the decimal value to an 8-bit hex value and use it to set the VBAT\_INF bits.

The rate at which the limiter threshold is lowered relative to the amount change in VBAT below the VBAT\_INF point is determined by the slope bits (Register 0x08, Bits[1:0]).

The slope is the ratio of the limiter threshold reduction to the VBAT voltage reduction.

 $Slope = \Delta Limiter Threshold / \Delta VBAT$ 

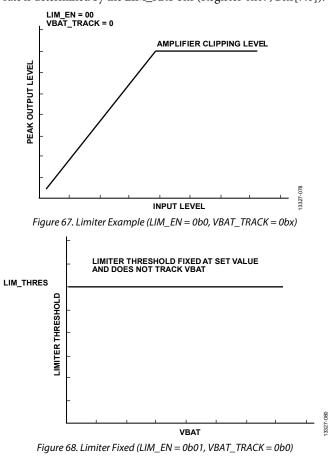
The slope ratio can be set from 1:1 to 4:1. This function is useful to prevent early shutdown under low battery conditions. As the VBAT voltage falls, the limiter threshold is lowered. This results in the lower output level and therefore helps to reduce the current drawn from the battery and in turn helps prevent early shutdown due to low VBAT.

The limiter offers various active modes which can be set using the LIM\_EN bits (Register 0x07, Bits[1:0]) and the VBAT\_TRACK bit, as shown in Table 19.

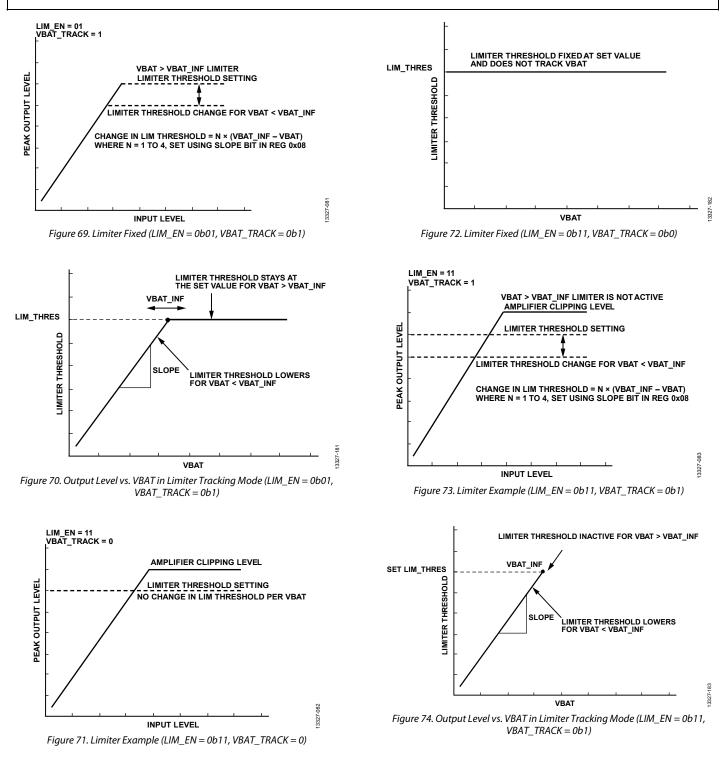
When LIM\_EN = 01, the limiter is enabled. When LIM\_EN = 10, the limiter mutes the output if VBAT falls below VBAT\_INF. When LIM\_EN = 11, the limiter engages only when the battery voltage is lower than VBAT\_INF. When VBAT is above VBAT\_INF, no limiting occurs. Note that there is hysteresis on VBAT\_INF for the limiter disengaging.

#### Table 19. Limiter Modes

The limiter, when active, reduces the gain of the amplifier. The rate of gain reduction or attack rate is determined by the LIM\_ATR bits (Register 0x07, Bits[5:4]). Similarly, when the signal level drops below the limiter threshold, the gain is restored. The gain release rate is determined by the LIM\_RRT bits (Register 0x07, Bits[7:6]).



| LIM_EN | VBAT_TRACK | Limiter  | VBAT < VBAT_INF       | VBAT > VBAT_INF       | Comments                    |
|--------|------------|----------|-----------------------|-----------------------|-----------------------------|
| 00     | 0/1        | No       | Not applicable        | Not applicable        | See Figure 67               |
| 01     | 0          | Fixed    | Use the set threshold | Use the set threshold | See Figure 68               |
| 01     | 1          | Variable | Lowers the threshold  | Use the set threshold | See Figure 69 and Figure 70 |
| 10     | 0/1        | Fixed    | Mutes the output      | Use the set threshold |                             |
| 11     | 0          | Fixed    | Use the set threshold | No limiting           | See Figure 71 and Figure 72 |
| 11     | 1          | Variable | Lowers the threshold  | No limiting           | See Figure 73 and Figure 74 |



# LAYOUT

As output power increases, care must be taken to lay out PCB traces and wires properly among the amplifier, load, and power supply; a poor layout increases voltage drops, consequently decreasing efficiency. A good practice is to use short, wide PCB tracks to decrease voltage drops and minimize inductance. For lowest dc resistance (DCR) and minimum inductance, ensure that track widths are at least 200 mil for every inch of length and use 1 oz or 2 oz copper. Use large traces for the power supply inputs and amplifier outputs. Proper grounding guidelines improve audio performance, minimize crosstalk between channels, and prevent switching noise from coupling into the audio signal.

To maintain high output swing and high peak output power, the PCB traces that connect the output pins to the load and supply pins must be as wide as possible to maintain the minimum trace resistances. It is also recommended that a large ground plane be used for minimum impedances. In addition, good PCB layout isolates critical analog paths from sources of high interference. Separate high frequency circuits (analog and digital) from low frequency circuits.

Properly designed multilayer PCBs can reduce EMI emission and increase immunity to the RF field by a factor of 10 or more, compared with double-sided boards. A multilayer board allows a complete layer to be used for the ground plane, whereas the ground plane side of a double-sided board is often disrupted by signal crossover. If the system has separate analog and digital ground and power planes, the analog ground plane must be directly beneath the analog power plane, and, similarly, the digital ground plane must be directly beneath the digital power plane. There must be no overlap between analog and digital ground planes or between analog and digital power planes.

# **BOOTSTRAP CAPACITORS**

The output stage of the SSM3515 uses a high-side NMOS driver, rather than PMOS. Therefore, a bootstrap supply is needed to drive the high-side NMOS. To generate the boosted gate driver voltage for the high-side NMOS, a  $0.22 \,\mu$ F bootstrap capacitor is used from each output pin to BST± pins. This capacitor boosts the voltage at BST± pins when the high-side NMOS turns on and acts as a floating power supply for that particular switching cycle. The bootstrap capacitor is charged during the low-side NMOS active period.

## POWER SUPPLY DECOUPLING

To ensure high efficiency, low total harmonic distortion (THD), and high power supply rejection ratio (PSRR), proper power supply decoupling is necessary. Noise transients on the power supply lines are short duration voltage spikes. These spikes can contain frequency components that extend into the hundreds of megahertz. The power supply input must be decoupled with a good quality, low ESL, low ESR bulk capacitor larger than  $220 \,\mu\text{F}$ . This capacitor bypasses low frequency noises to the ground plane.

For high frequency transient noises, place 1  $\mu F$  capacitors as close as possible to the PVDD pins of the device.

# **REGISTER SUMMARY**

#### Table 20. Register Summary

| Reg. | Name                      | Bits  | Bit 7          | Bit 6         | Bit 5                           | Bit 4     | Bit 3    | Bit 2          | Bit 1         | Bit 0    | Reset | RW  |
|------|---------------------------|-------|----------------|---------------|---------------------------------|-----------|----------|----------------|---------------|----------|-------|-----|
| 0x00 | Power Control             | [7:0] | APWDN_<br>EN   | BSNS_<br>PWDN |                                 | RES       | ERVED    |                | S_RST         | SPWDN    | 0x81  | R/W |
| 0x01 | Gain and Edge<br>Control  | [7:0] |                | RESERVED      | RESERVED EDGE RESERVED ANA_GAIN |           | 0x01     | R/W            |               |          |       |     |
| 0x02 | DAC Control               | [7:0] | DAC_HV         | DAC_MUTE      | DAC_HPF DAC_LPM RESERVED DAC_FS |           |          |                | 0x32          | R/W      |       |     |
| 0x03 | DAC Volume<br>Control     | [7:0] |                | VOL           |                                 |           |          |                | 0x40          | R/W      |       |     |
| 0x04 | SAI Control 1             | [7:0] | DAC_POL        | BCLK_POL      |                                 | TDM_BCLKS | 5        | FSYNC_<br>MODE | SDATA_<br>FMT | SAI_MODE | 0x11  | R/W |
| 0x05 | SAI Control 2             | [7:0] | DATA_<br>WIDTH |               |                                 |           |          |                | 0x00          | R/W      |       |     |
| 0x06 | Battery Voltage<br>Output | [7:0] |                |               |                                 | V         | BAT      |                |               |          | 0x00  | R   |
| 0x07 | Limiter Control 1         | [7:0] | LIN            | I_RRT         | LIM                             | _ATR      | RESERVED | VBAT_<br>TRACK | LIN           | 1_EN     | 0xA4  | R/W |
| 0x08 | Limiter Control 2         | [7:0] |                |               | LIM_THRES                       |           | •        | RESERVED       | SL            | OPE      | 0x51  | R/W |
| 0x09 | Limiter Control 3         | [7:0] |                | VBAT_INF      |                                 |           |          |                | 0x22          | R/W      |       |     |
| 0x0A | Status                    | [7:0] | RESERVED       | UVLO_VREG     | LIM_EG                          | CLIP      | AMP_OC   | OTF            | OTW           | BAT_WARN | 0x00  | R   |
| 0x0B | Fault Control             | [7:0] | OTW            | /_gain        | MRCV                            | MAX       | K_AR     | ARCV_UV        | ARCV_OT       | ARCV_OC  | 0x18  | R/W |

# **REGISTER DETAILS**

## POWER CONTROL REGISTER

#### Address: 0x00, Reset: 0x81, Name: Power Control

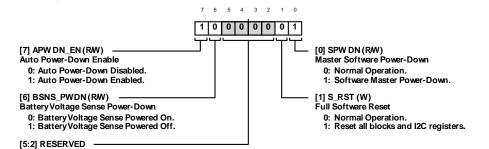


Table 21. Bit Descriptions for Power Control

| Bits  | Bit Name  | Settings | Description   | Reset | Access |
|-------|-----------|----------|---|-------|--------|
| 7     | APWDN_EN  |          | Auto Power-Down Enable. Auto power-down automatically puts the IC in a low power state when 2048 consecutive zero input samples have been received.   | 0x1   | R/W    |
|       |           | 0        | Auto Power-Down Disabled.   |       |        |
|       |           | 1        | Auto Power-Down Enabled. When APWDN_EN = 1 the device automatically powers down when 2048 consecutive zero value input samples have been received. The device automatically powers up when a single nonzero sample is received. |       |        |
| 6     | BSNS_PWDN |          | Battery Voltage Sense Power-Down.   | 0x0   | R/W    |
|       |           | 0        | Battery Voltage Sense Powered On.   |       |        |
|       |           | 1        | Battery Voltage Sense Powered Off.  |       |        |
| [5:2] | RESERVED  |          | Reserved.   | 0x0   | R/W    |
| 1     | S_RST     |          | Full Software Reset.  | 0x0   | W      |
|       |           | 0        | Normal Operation.   |       |        |
|       |           | 1        | Reset all Blocks and I <sup>2</sup> C Registers.  |       |        |
| 0     | SPWDN     |          | Master Software Power-Down. Software power-down puts all blocks except the I <sup>2</sup> C interface in a low-power state.   | 0x1   | R/W    |
|       |           | 0        | Normal Operation.   |       |        |
|       |           | 1        | Software Master Power-Down.   |       |        |

## GAIN AND EDGE CONTROL REGISTER

Address: 0x01, Reset: 0x01, Name: Gain and Edge Control

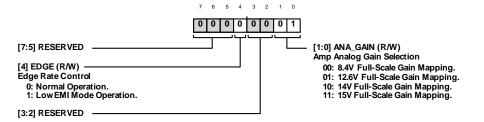


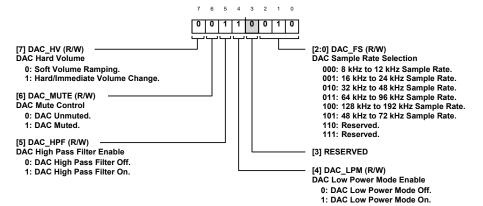
Table 22. Bit Descriptions for Gain and Edge Control

| Bits  | Bit Name | Settings | Description | Reset | Access |
|-------|----------|----------|-------------|-------|--------|
| [7:5] | RESERVED |          | Reserved.   | 0x0   | R/W    |

| Bits  | Bit Name | Settings | Description  | Reset | Access |
|-------|----------|----------|--|-------|--------|
| 4     | EDGE     |          | Edge Rate Control. This controls the edge speed of the power stage. The low EMI operation mode reduces the edge speed, lowering EMI and power efficiency | 0x0   | R/W    |
|       |          | 0        | Normal Operation.  |       |        |
|       |          | 1        | Low EMI Mode Operation.  |       |        |
| [3:2] | RESERVED |          | Reserved.  | 0x0   | R/W    |
| [1:0] | ANA_GAIN |          | Amp Analog Gain Selection.   | 0x1   | R/W    |
|       |          | 00       | 8.4 V Full-Scale Gain Mapping.   |       |        |
|       |          | 01       | 12.6 V Full-Scale Gain Mapping.  |       |        |
|       |          | 10       | 14 V Full-Scale Gain Mapping.  |       |        |
|       |          | 11       | 15 V Full-Scale Gain Mapping.  |       |        |

## DAC CONTROL REGISTER

Address: 0x02, Reset: 0x32, Name: DAC Control



#### Table 23. Bit Descriptions for DAC Control

| Bits | Bit Name | Settings | Description                   | Reset | Access |
|------|----------|----------|-------------------------------|-------|--------|
| 7    | DAC_HV   |          | DAC Hard Volume.              | 0x0   | R/W    |
|      |          | 0        | Soft Volume Ramping.          |       |        |
|      |          | 1        | Hard/Immediate Volume Change. |       |        |
| 6    | DAC_MUTE |          | DAC Mute Control.             | 0x0   | R/W    |
|      |          | 0        | DAC Unmuted.                  |       |        |
|      |          | 1        | DAC Muted.                    |       |        |
| 5    | DAC_HPF  |          | DAC High-Pass Filter Enable.  | 0x1   | R/W    |
|      |          | 0        | DAC High-Pass Filter Off.     |       |        |
|      |          | 1        | DAC High-Pass Filter On.      |       |        |
| 4    | DAC_LPM  |          | DAC Low Power Mode Enable.    | 0x1   | R/W    |
|      |          | 0        | DAC Low Power Mode Off.       |       |        |
|      |          | 1        | DAC Low Power Mode On.        |       |        |
| 3    | RESERVED |          | Reserved.                     | 0x0   | R/W    |

| Bits  | Bit Name | Settings | Description                     | Reset | Access |
|-------|----------|----------|---------------------------------|-------|--------|
| [2:0] | DAC_FS   |          | DAC Sample Rate Selection.      | 0x2   | R/W    |
|       |          | 000      | 8 kHz to 12 kHz Sample Rate.    |       |        |
|       |          | 001      | 16 kHz to 24 kHz Sample Rate.   |       |        |
|       |          | 010      | 32 kHz to 48 kHz Sample Rate.   |       |        |
|       |          | 011      | 64 kHz to 96 kHz Sample Rate.   |       |        |
|       |          | 100      | 128 kHz to 192 kHz Sample Rate. |       |        |
|       |          | 101      | 48 kHz to 72 kHz Sample Rate.   |       |        |
|       |          | 110      | Reserved.                       |       |        |
|       |          | 111      | Reserved.                       |       |        |

7 6 5 4 3 2 1 0

## DAC VOLUME CONTROL REGISTER

Address: 0x03, Reset: 0x40, Name: DAC Volume Control

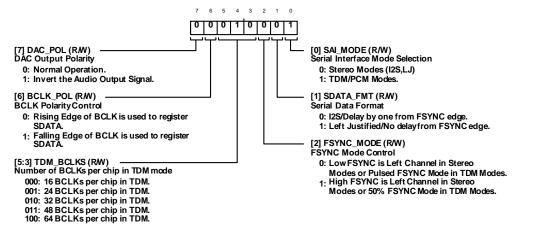
[7:0] VOL (R.W) Volume Control 000000001: +24 dB. 00000001: +23.625 dB. 00000010: +23.35 dB. ... 11111101: -70.875 dB. 11111110: -71.25 dB. 11111111: Mute.

## Table 24. Bit Descriptions for DAC Volume Control

| Bits  | Bit Name | Settings | Description     | Reset | Access |
|-------|----------|----------|-----------------|-------|--------|
| [7:0] | VOL      |          | Volume Control. | 0x40  | R/W    |
|       |          | 00000000 | +24 dB.         |       |        |
|       |          | 00000001 | +23.625 dB.     |       |        |
|       |          | 00000010 | +23.35 dB.      |       |        |
|       |          | 00000011 | +22.875 dB.     |       |        |
|       |          | 00000100 | +22.5 dB.       |       |        |
|       |          | 00000101 |                 |       |        |
|       |          | 00111111 | +0.375 dB.      |       |        |
|       |          | 0100000  | 0.              |       |        |
|       |          | 01000001 | –0.375 dB.      |       |        |
|       |          | 01000010 |                 |       |        |
|       |          | 11111101 | –70.875 dB.     |       |        |
|       |          | 11111110 | -71.25 dB.      |       |        |
|       |          | 11111111 | Mute.           |       |        |

# SAI CONTROL 1 REGISTER

#### Address: 0x04, Reset: 0x11, Name: SAI Control 1

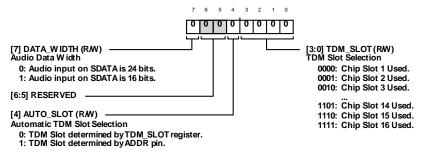


#### Table 25. Bit Descriptions for SAI Control 1

| Bits  | Bit Name   | Settings | Description   | Reset | Access |
|-------|------------|----------|---|-------|--------|
| 7     | DAC_POL    |          | DAC Output Polarity.  | 0x0   | R/W    |
|       |            | 0        | Normal Operation.   |       |        |
|       |            | 1        | Invert the Audio Output Signal.   |       |        |
| 6     | BCLK_POL   |          | BCLK Polarity Control.  | 0x0   | R/W    |
|       |            | 0        | Rising Edge of BCLK is Used to Register SDATA.  |       |        |
|       |            | 1        | Falling Edge of BCLK is Used to Register SDATA.   |       |        |
| [5:3] | TDM_BCLKS  |          | Number of BCLKs per Chip in TDM Mode. Any number of BCLK cycles per FSYNC can be used in stereo modes (I <sup>2</sup> S/LJ) or in TDM mode with only one chip. When in TDM mode and having multiple chips on the TDM bus, the number of BCLKs per chip must be defined. | 0x2   | R/W    |
|       |            | 000      | 16 BCLKs per Chip in TDM.   |       |        |
|       |            | 001      | 24 BCLKs per Chip in TDM.   |       |        |
|       |            | 010      | 32 BCLKs per Chip in TDM.   |       |        |
|       |            | 011      | 48 BCLKs per Chip in TDM.   |       |        |
|       |            | 100      | 64 BCLKs per Chip in TDM.   |       |        |
| 2     | FSYNC_MODE |          | FSYNC Mode Control.   | 0x0   | R/W    |
|       |            | 0        | Low FSYNC is Left Channel in Stereo Modes or Pulsed FSYNC Mode in TDM Modes.  |       |        |
|       |            | 1        | High FSYNC is Left Channel in Stereo Modes or 50% FSYNC Mode in TDM Modes.  |       |        |
| 1     | SDATA_FMT  |          | Serial Data Format.   | 0x0   | R/W    |
|       |            | 0        | I <sup>2</sup> S/Delay by One from FSYNC Edge.  |       |        |
|       |            | 1        | Left Justified/No Delay from FSYNC Edge.  |       |        |
| 0     | SAI_MODE   |          | Serial Interface Mode Selection.  | 0x1   | R/W    |
|       |            | 0        | Stereo Modes (I²S, LJ).   |       |        |
|       |            | 1        | TDM/PCM Modes.  |       |        |

## SAI CONTROL 2 REGISTER

Address: 0x05, Reset: 0x00, Name: SAI Control 2



| Bits  | Bit Name   | Settings | Description                                   | Reset | Access |
|-------|------------|----------|---|-------|--------|
| 7     | DATA_WIDTH |          | Audio Data Width.                             | 0x0   | R/W    |
|       |            | 0        | Audio Input on SDATA is 24 Bits.              |       |        |
|       |            | 1        | Audio Input on SDATA is 16 Bits.              |       |        |
| [6:5] | RESERVED   |          | Reserved.                                     | 0x0   | R/W    |
| 4     | AUTO_SLOT  |          | Automatic TDM Slot Selection.                 | 0x0   | R/W    |
|       |            | 0        | TDM Slot Determined by the TDM_SLOT Register. |       |        |
|       |            | 1        | TDM Slot Determined by the ADDR Pin.          |       |        |
| [3:0] | TDM_SLOT   |          | TDM Slot Selection.                           | 0x0   | R/W    |
|       |            | 0000     | Chip Slot 1 Used.                             |       |        |
|       |            | 0001     | Chip Slot 2 Used.                             |       |        |
|       |            | 0010     | Chip Slot 3 Used.                             |       |        |
|       |            | 0011     | Chip Slot 4 Used.                             |       |        |
|       |            | 0100     | Chip Slot 5 Used.                             |       |        |
|       |            | 0101     | Chip Slot 6 Used.                             |       |        |
|       |            | 0110     | Chip Slot 7 Used.                             |       |        |
|       |            | 0111     | Chip Slot 8 Used.                             |       |        |
|       |            | 1000     | Chip Slot 9 Used.                             |       |        |
|       |            | 1001     | Chip Slot 10 Used.                            |       |        |
|       |            | 1010     | Chip Slot 11 Used.                            |       |        |
|       |            | 1011     | Chip Slot 12 Used.                            |       |        |
|       |            | 1100     | Chip Slot 13 Used.                            |       |        |
|       |            | 1101     | Chip Slot 14 Used.                            |       |        |
|       |            | 1110     | Chip Slot 15 Used.                            |       |        |
|       |            | 1111     | Chip Slot 16 Used.                            |       |        |

## **BATTERY VOLTAGE OUTPUT REGISTER**

Address: 0x06, Reset: 0x00, Name: Battery Voltage Output

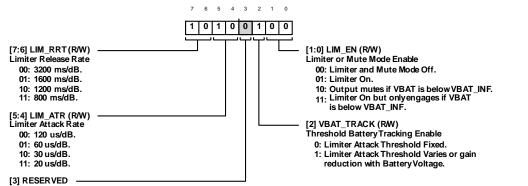
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|---|---|---|---|---|---|---|
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
|   |   |   |   |   |   |   |   |

[7:0] VBAT (R) 8-Bit Unsigned Battery Voltage

| Bits  | Bit Name | Settings | Description                    | Reset | Access |
|-------|----------|----------|--------------------------------|-------|--------|
| [7:0] | VBAT     |          | 8-Bit Unsigned Battery Voltage | 0x0   | R      |

## LIMITER CONTROL 1 REGISTER

Address: 0x07, Reset: 0xA4, Name: Limiter Control 1

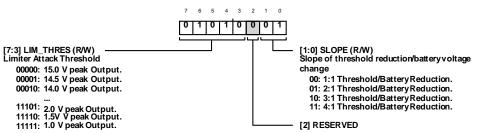


#### Table 28. Bit Descriptions for Limiter Control 1

| Bits  | Bit Name   | Settings | Description   | Reset | Access |
|-------|------------|----------|---|-------|--------|
| [7:6] | LIM_RRT    |          | Limiter Release Rate.   | 0x2   | R/W    |
|       |            | 00       | 3200 ms/dB.   |       |        |
|       |            | 01       | 1600 ms/dB.   |       |        |
|       |            | 10       | 1200 ms/dB.   |       |        |
|       |            | 11       | 800 ms/dB.  |       |        |
| [5:4] | LIM_ATR    |          | Limiter Attack Rate.  | 0x2   | R/W    |
|       |            | 00       | 120 μs/dB.  |       |        |
|       |            | 01       | 60 μs/dB.   |       |        |
|       |            | 10       | 30 μs/dB.   |       |        |
|       |            | 11       | 20 μs/dB.   |       |        |
| 3     | RESERVED   |          | Reserved.   | 0x0   | R/W    |
| 2     | VBAT_TRACK |          | Threshold Battery Tracking Enable.                                      | 0x1   | R/W    |
|       |            | 0        | Limiter Attack Threshold Fixed.   |       |        |
|       |            | 1        | Limiter Attack Threshold Varies or Gain Reduction with Battery Voltage. |       |        |
| [1:0] | LIM_EN     |          | Limiter or Mute Mode Enable.  | 0x0   | R/W    |
|       |            | 00       | Limiter and Mute Mode Off.  |       |        |
|       |            | 01       | Limiter On.   |       |        |
|       |            | 10       | Output Mutes if VBAT is Below VBAT_INF.                                 |       |        |
|       |            | 11       | Limiter On But Only Engages if VBAT is Below VBAT_INF.                  |       |        |

# LIMITER CONTROL 2 REGISTER

Address: 0x08, Reset: 0x51, Name: Limiter Control 2



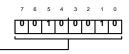
#### Table 29. Bit Descriptions for Limiter Control 2

| Bits  | Bit Name  | Settings | Description               | Reset | Access |
|-------|-----------|----------|---------------------------|-------|--------|
| [7:3] | LIM_THRES |          | Limiter Attack Threshold. | 0xA   | R/W    |
|       |           | 00000    | 15.0 V peak Output.       |       |        |
|       |           | 00001    | 14.5 V peak Output.       |       |        |
|       |           | 00010    | 14.0 V peak Output.       |       |        |
|       |           | 00011    | 13.5 V peak Output.       |       |        |
|       |           | 00100    | 13.0 V peak Output.       |       |        |
|       |           | 00101    | 12.5 V peak Output.       |       |        |
|       |           | 00110    | 12.0 V peak Output.       |       |        |
|       |           | 00111    | 11.5 V peak Output.       |       |        |
|       |           | 01000    | 11.0 V peak Output.       |       |        |
|       |           | 01001    | 10.5 V peak Output.       |       |        |
|       |           | 01010    | 10.0 V peak Output.       |       |        |
|       |           | 01011    | 9.5 V peak Output.        |       |        |
|       |           | 01100    | 9.0 V peak Output.        |       |        |
|       |           | 01101    | 8.5 V peak Output.        |       |        |
|       |           | 01110    | 8.25 V peak Output.       |       |        |
|       |           | 01111    | 8.0 V peak Output.        |       |        |
|       |           | 10000    | 7.75 V peak Output.       |       |        |
|       |           | 10001    | 7.5 V peak Output.        |       |        |
|       |           | 10010    | 7.25 V peak Output.       |       |        |
|       |           | 10011    | 7.0 V peak Output.        |       |        |
|       |           | 10100    | 6.5 V peak Output.        |       |        |
|       |           | 10101    | 6.0 V peak Output.        |       |        |
|       |           | 10110    | 5.5 V peak Output.        |       |        |
|       |           | 10111    | 5.0 V peak Output.        |       |        |
|       |           | 11000    | 4.5 V peak Output.        |       |        |
|       |           | 11001    | 4.0 V peak Output.        |       |        |
|       |           | 11010    | 3.5 V peak Output.        |       |        |
|       |           | 11011    | 3.0 V peak Output.        |       |        |
|       |           | 11100    | 2.5 V peak Output.        |       |        |
|       |           | 11101    | 2.0 V peak Output.        |       |        |
|       |           | 11110    | 1.5 V peak Output.        |       |        |
|       |           | 11111    | 1.0 V peak Output.        |       |        |

| Bits  | Bit Name | Settings | Description  | Reset | Access |
|-------|----------|----------|--|-------|--------|
| 2     | RESERVED |          | Reserved.  | 0x0   | R/W    |
| [1:0] | SLOPE    |          | Slope of Threshold Reduction/Battery Voltage Change. | 0x1   | R/W    |
|       |          | 00       | 1:1 Threshold/Battery Reduction.                     |       |        |
|       |          | 01       | 2:1 Threshold/Battery Reduction.                     |       |        |
|       |          | 10       | 3:1 Threshold/Battery Reduction.                     |       |        |
|       |          | 11       | 4:1 Threshold/Battery Reduction.                     |       |        |

## LIMITER CONTROL 3 REGISTER

Address: 0x09, Reset: 0x22, Name: Limiter Control 3



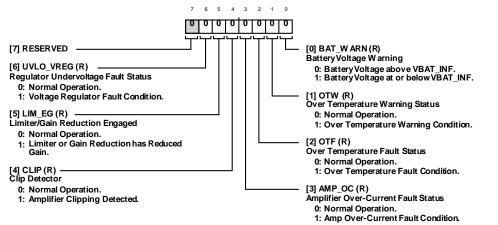
[7:0] VBAT\_INF (RW) \_\_\_\_\_ Battery Voltage Inflection Point

#### Table 30. Bit Descriptions for Limiter Control 3

| Bits  | Bit Name | Settings | Description  | Reset | Access |
|-------|----------|----------|--|-------|--------|
| [7:0] | VBAT_INF |          | Battery Voltage Inflection Point. This is the VBAT sense value at which the limiter either activates or starts reducing the threshold. It corresponds to the value that can be read in the VBAT read only status register. To calculate this value in volts, refer to the VBAT Sensing section. <i>Voltage</i> = $3.8 + 12.4 \times Decimal Value/255$ . | 0x22  | R/W    |

## **STATUS REGISTER**

Address: 0x0A, Reset: 0x00, Name: Status



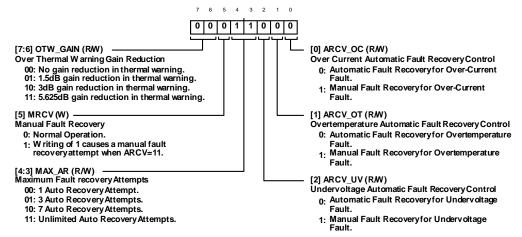
#### Table 31. Bit Descriptions for Status

| Bits | Bit Name  | Settings | Description                                 | Reset | Access |
|------|-----------|----------|---|-------|--------|
| 7    | RESERVED  |          | Reserved.                                   | 0x0   | R      |
| 6    | UVLO_VREG |          | Regulator Undervoltage Fault Status.        | 0x0   | R      |
|      |           | 0        | Normal Operation.                           |       |        |
|      |           | 1        | Voltage Regulator Fault Condition.          |       |        |
| 5    | LIM_EG    |          | Limiter/Gain Reduction Engaged.             | 0x0   | R      |
|      |           | 0        | Normal Operation.                           |       |        |
|      |           | 1        | Limiter or Gain Reduction has Reduced Gain. |       |        |

| Bits | Bit Name | Settings | Description                           | Reset | Access |
|------|----------|----------|---------------------------------------|-------|--------|
| 4    | CLIP     |          | Clip Detector.                        | 0x0   | R      |
|      |          | 0        | Normal Operation.                     |       |        |
|      |          | 1        | Amplifier Clipping Detected.          |       |        |
| 3    | AMP_OC   |          | Amplifier Overcurrent Fault Status.   | 0x0   | R      |
|      |          | 0        | Normal Operation.                     |       |        |
|      |          | 1        | Amp Over-Current Fault Condition.     |       |        |
| 2    | OTF      |          | Overtemperature Fault Status.         | 0x0   | R      |
|      |          | 0        | Normal Operation.                     |       |        |
|      |          | 1        | Overtemperature Fault Condition.      |       |        |
| 1    | OTW      |          | Overtemperature Warning Status.       | 0x0   | R      |
|      |          | 0        | Normal Operation.                     |       |        |
|      |          | 1        | Overtemperature Warning Condition.    |       |        |
| 0    | BAT_WARN |          | Battery Voltage Warning.              | 0x0   | R      |
|      |          | 0        | Battery Voltage Above VBAT_INF.       |       |        |
|      |          | 1        | Battery Voltage at or Below VBAT_INF. |       |        |

## FAULT CONTROL REGISTER

Address: 0x0B, Reset: 0x18, Name: Fault Control



| Table 32. Bit Descriptions for Fault Control |
|--|
|--|

| Bits  | Bit Name | Settings | Description   | Reset | Access |
|-------|----------|----------|---|-------|--------|
| [7:6] | OTW_GAIN |          | Over Thermal Warning Gain Reduction.                                | 0x0   | R/W    |
|       |          | 00       | No Gain Reduction in Thermal Warning.                               |       |        |
|       |          | 01       | 1.5 dB Gain Reduction in Thermal Warning.                           |       |        |
|       |          | 10       | 3 dB Gain Reduction in Thermal Warning.                             |       |        |
|       |          | 11       | 5.625 dB Gain Reduction in Thermal Warning.                         |       |        |
| 5     | MRCV     |          | Manual Fault Recovery.  | 0x0   | W      |
|       |          | 0        | Normal Operation.   |       |        |
|       |          | 1        | Writing of 1 Causes a Manual Fault Recovery Attempt when ARCV = 11. |       |        |

| Bits  | Bit Name | Settings | Description  | Reset | Access |
|-------|----------|----------|--|-------|--------|
| [4:3] | MAX_AR   |          | Maximum Fault Recovery Attempts. The maximum autorecovery register determines how many attempts at autorecovery are performed. | 0x3   | R/W    |
|       |          | 00       | 1 Autorecovery Attempt.  |       |        |
|       |          | 01       | 3 Autorecovery Attempts.   |       |        |
|       |          | 10       | 7 Autorecovery Attempts.   |       |        |
|       |          | 11       | Unlimited Autorecovery Attempts.   |       |        |
| 2     | ARCV_UV  |          | Undervoltage Automatic Fault Recovery Control.   | 0x0   | R/W    |
|       |          | 0        | Automatic Fault Recovery for Undervoltage Fault.   |       |        |
|       |          | 1        | Manual Fault Recovery for Undervoltage Fault.  |       |        |
| 1     | ARCV_OT  |          | Overtemperature Automatic Fault Recovery Control.  | 0x0   | R/W    |
|       |          | 0        | Automatic Fault Recovery for Overtemperature Fault.  |       |        |
|       |          | 1        | Manual Fault Recovery for Overtemperature Fault.   |       |        |
| 0     | ARCV_OC  |          | Overcurrent Automatic Fault Recovery Control.  | 0x0   | R/W    |
|       |          | 0        | Automatic Fault Recovery for Overcurrent Fault.  |       |        |
|       |          | 1        | Manual Fault Recovery for Overcurrent Fault.   |       |        |

# **TYPICAL APPLICATION CIRCUIT**

Figure 75 shows a typical application circuit for a single channel output.

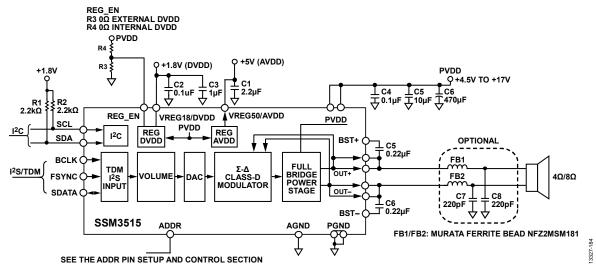


Figure 75. Typical Application Circuit for Single Channel Output